

FIG.1

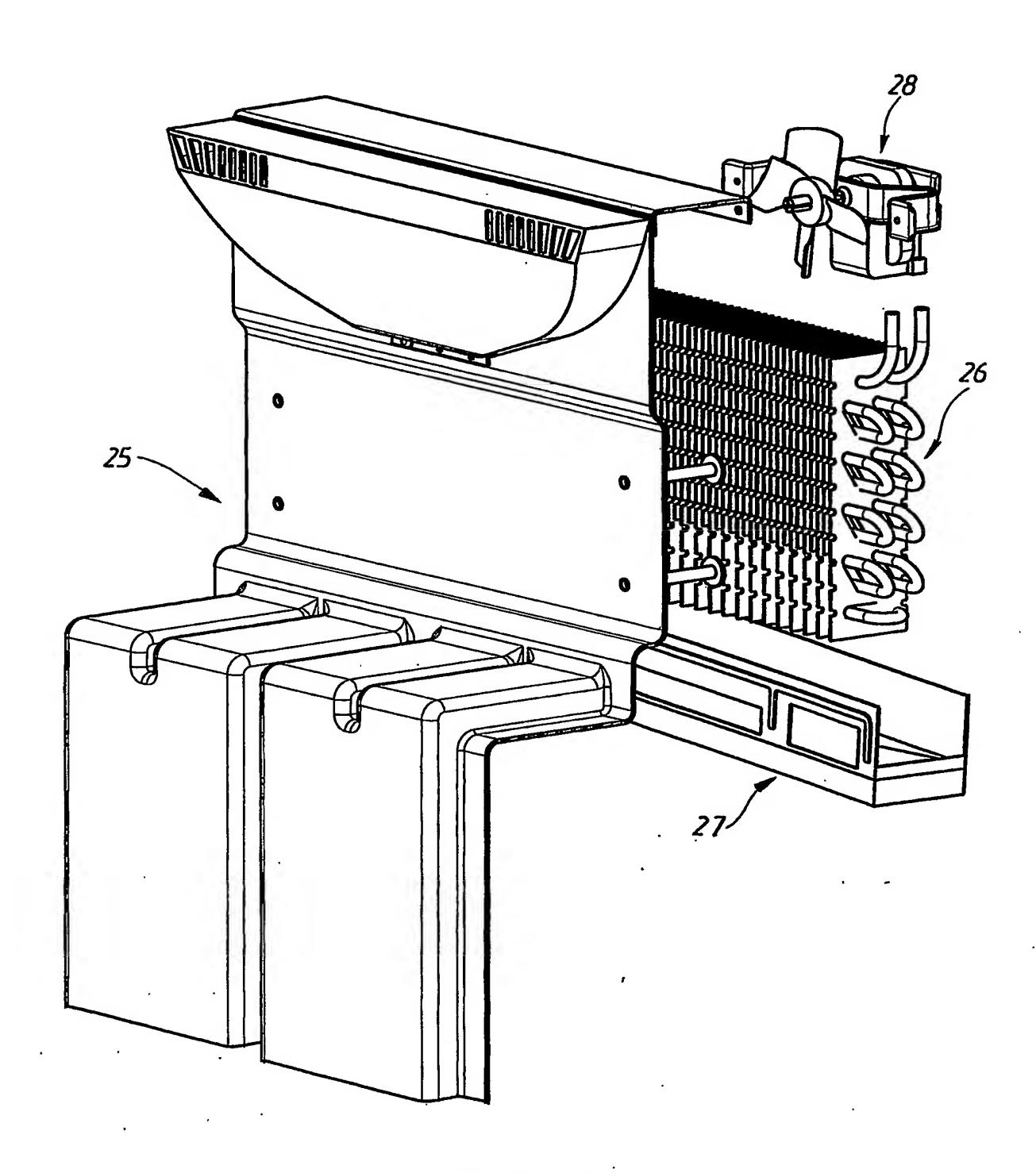


FIG. 2

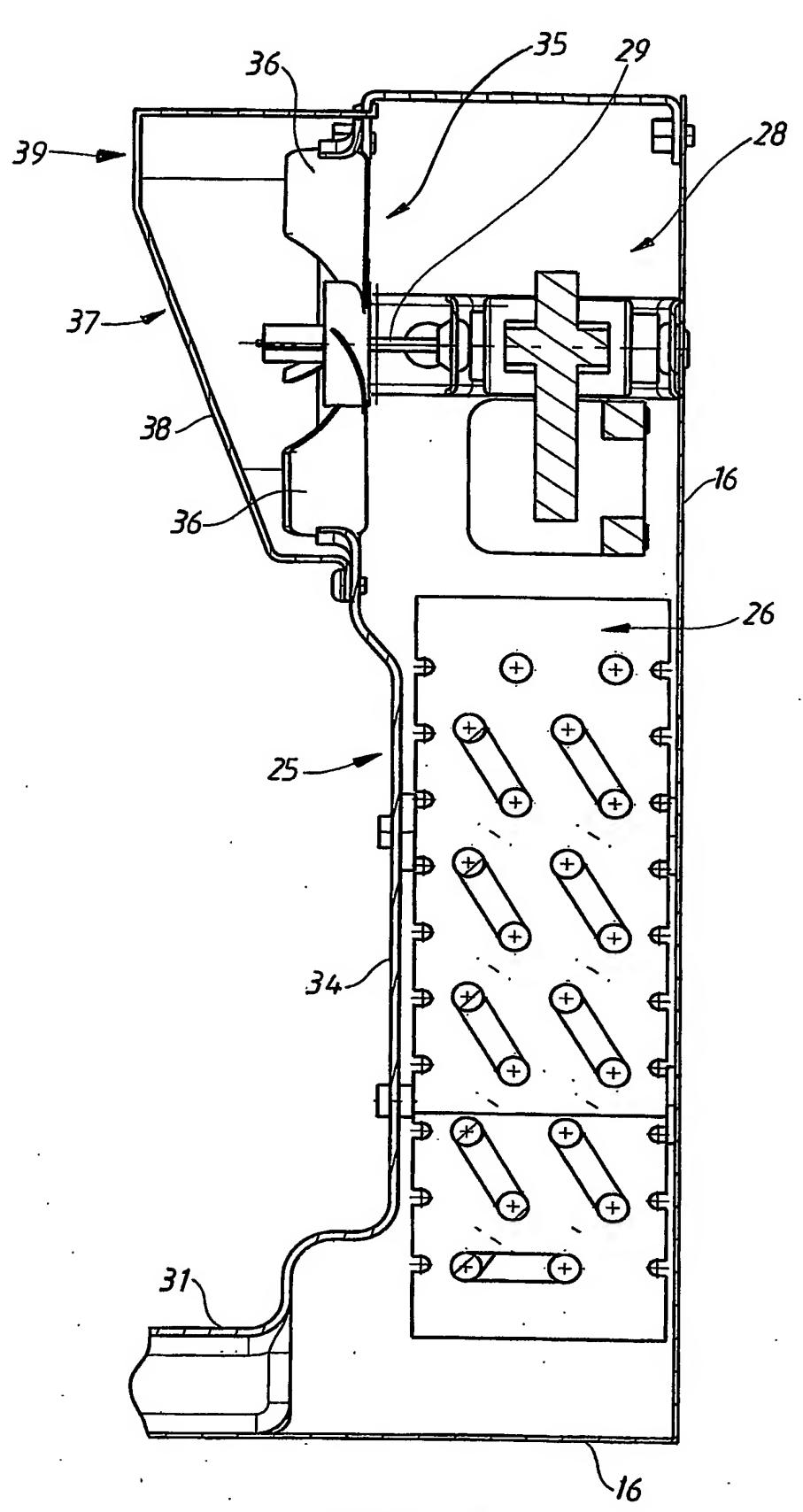
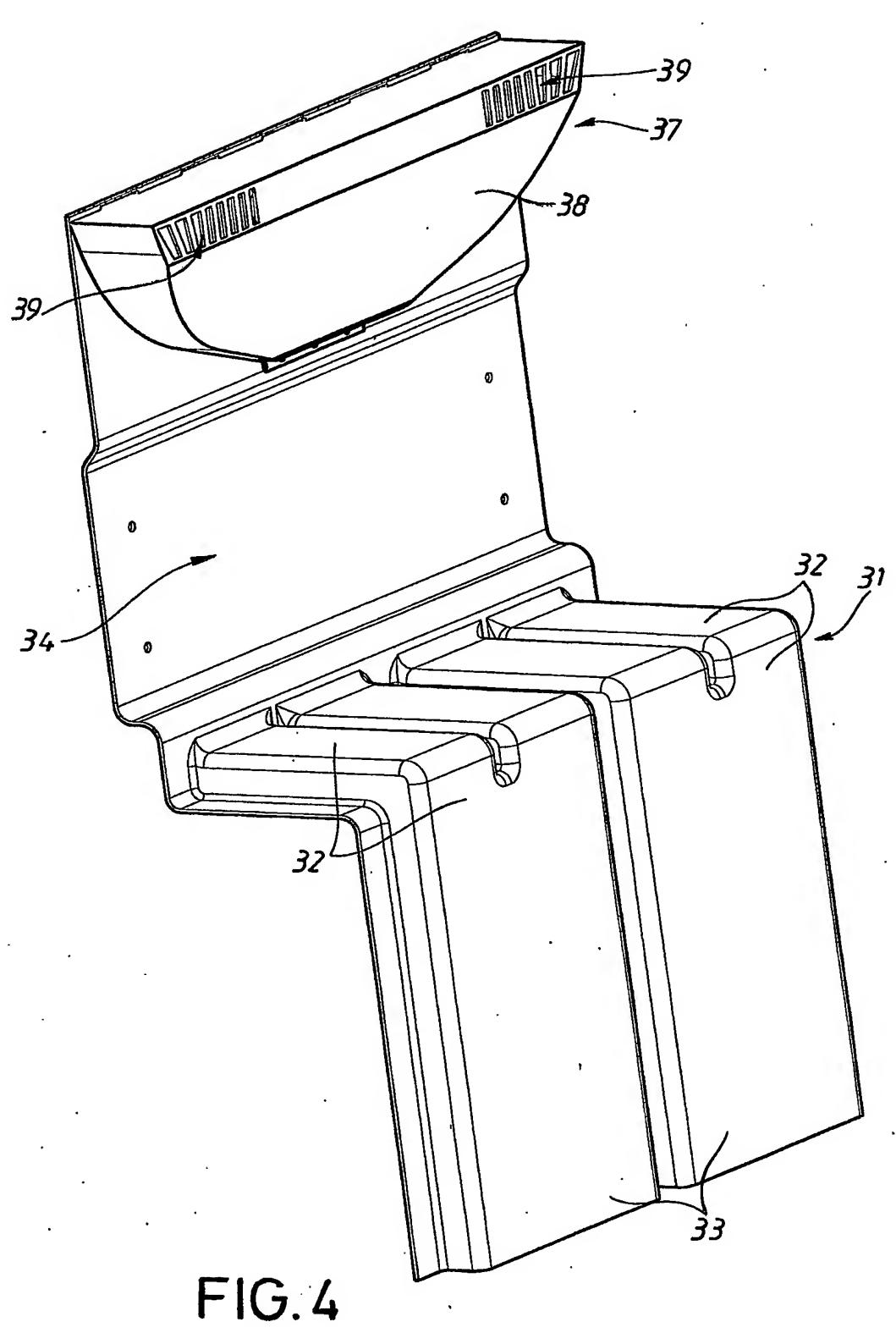


FIG. 3



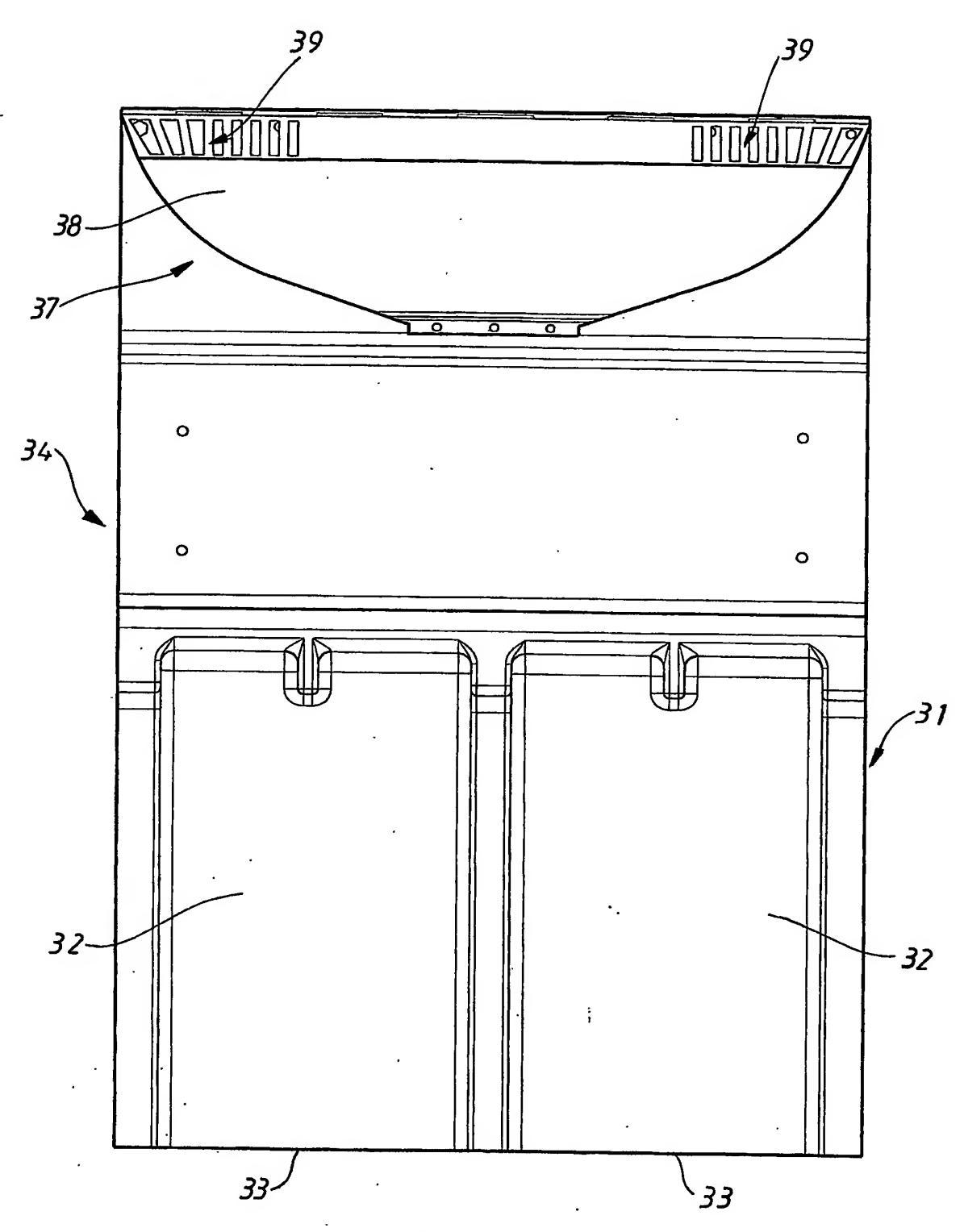


FIG. 5

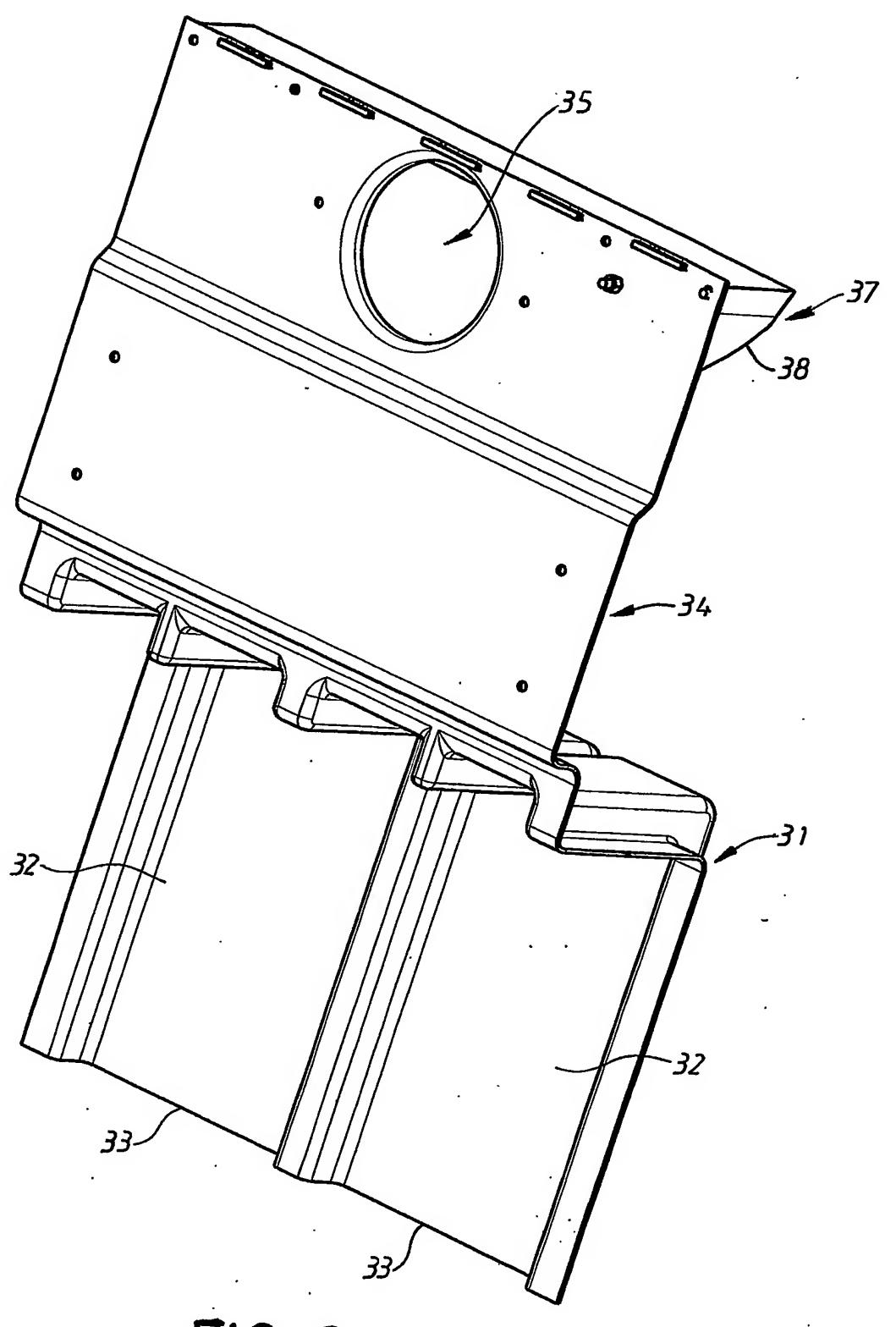


FIG. 6

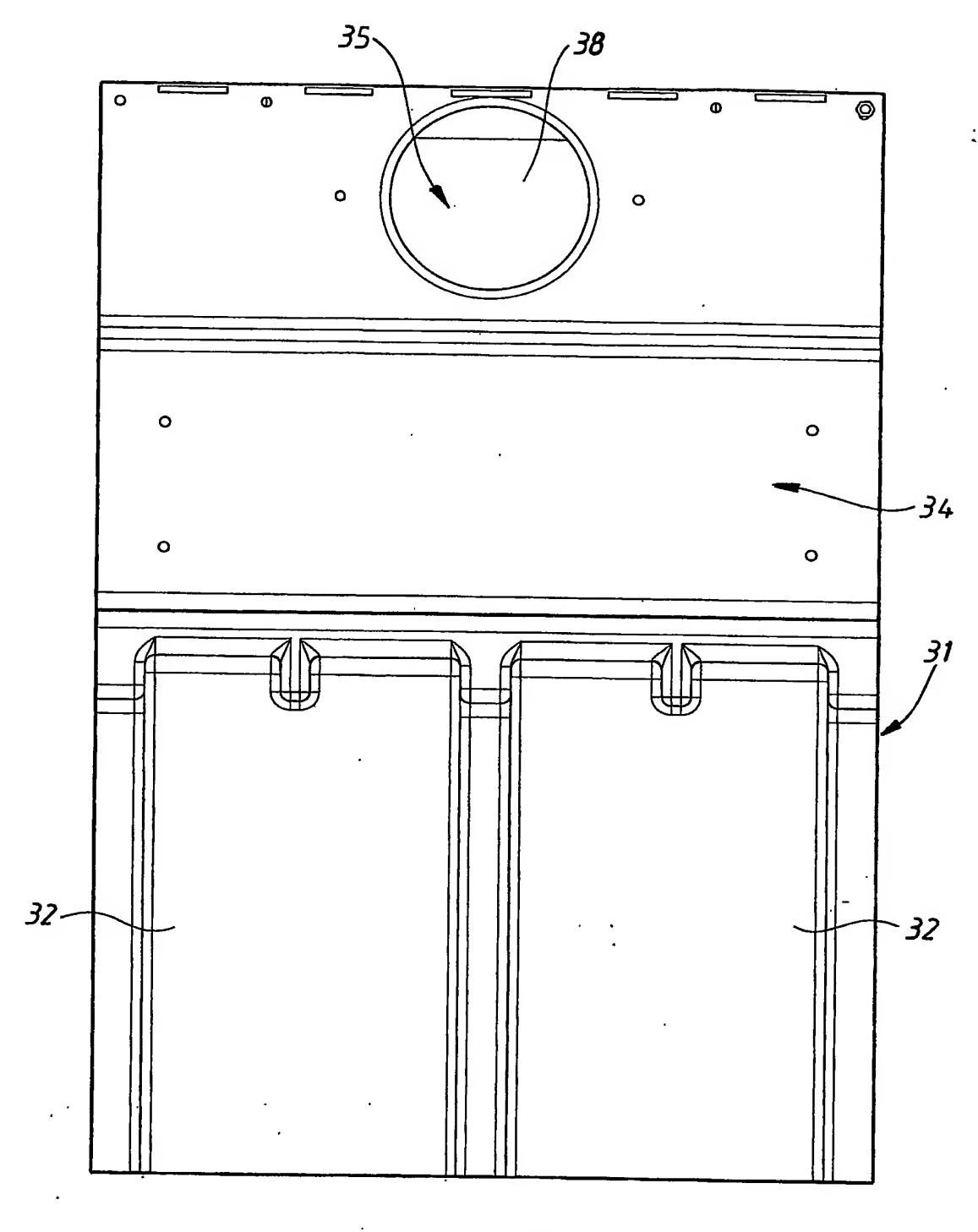


FIG. 7

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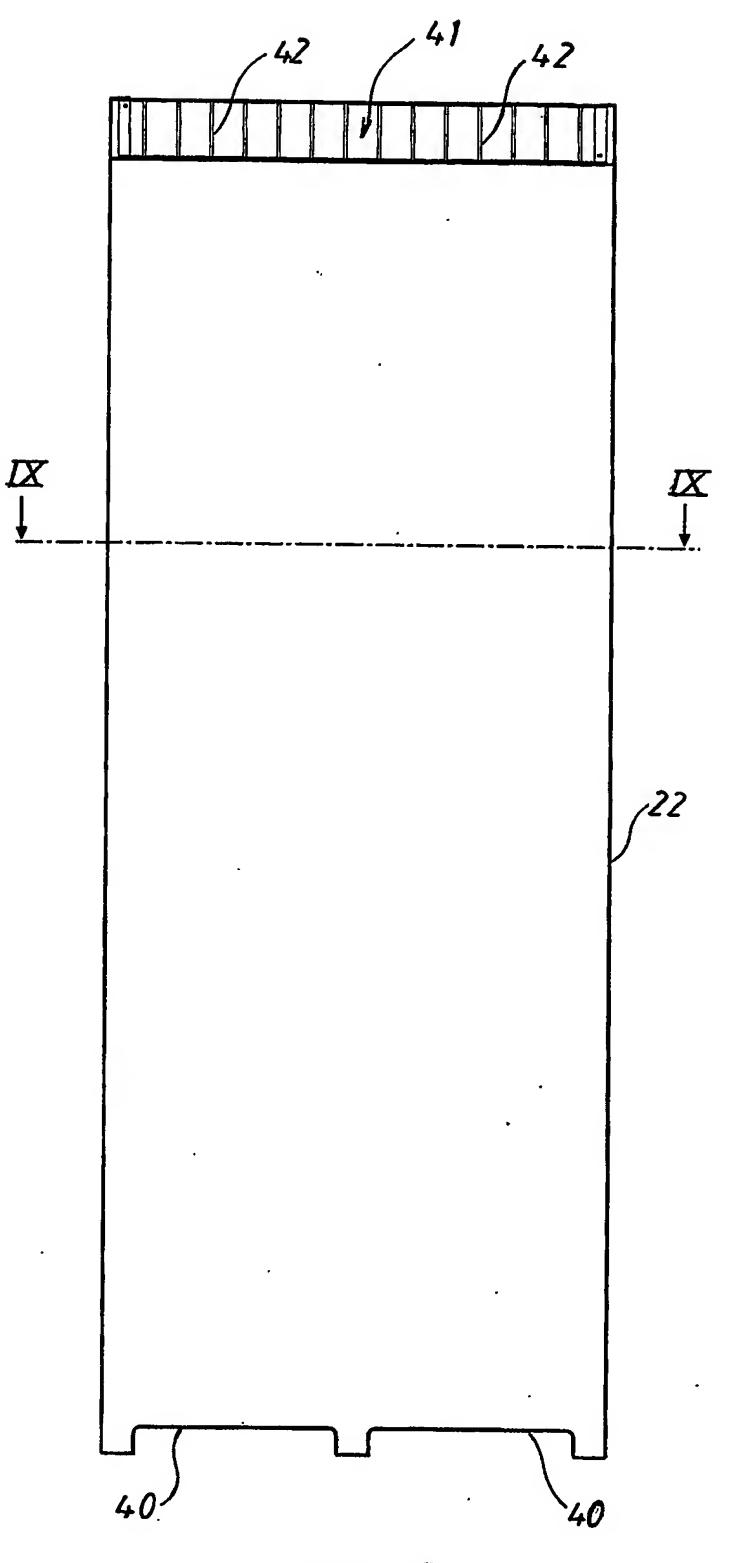


FIG.8

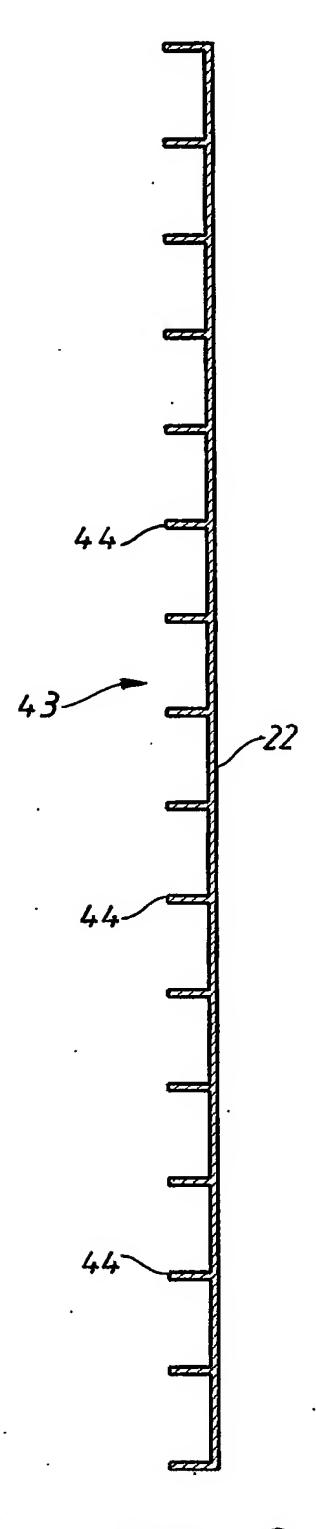


FIG. 9

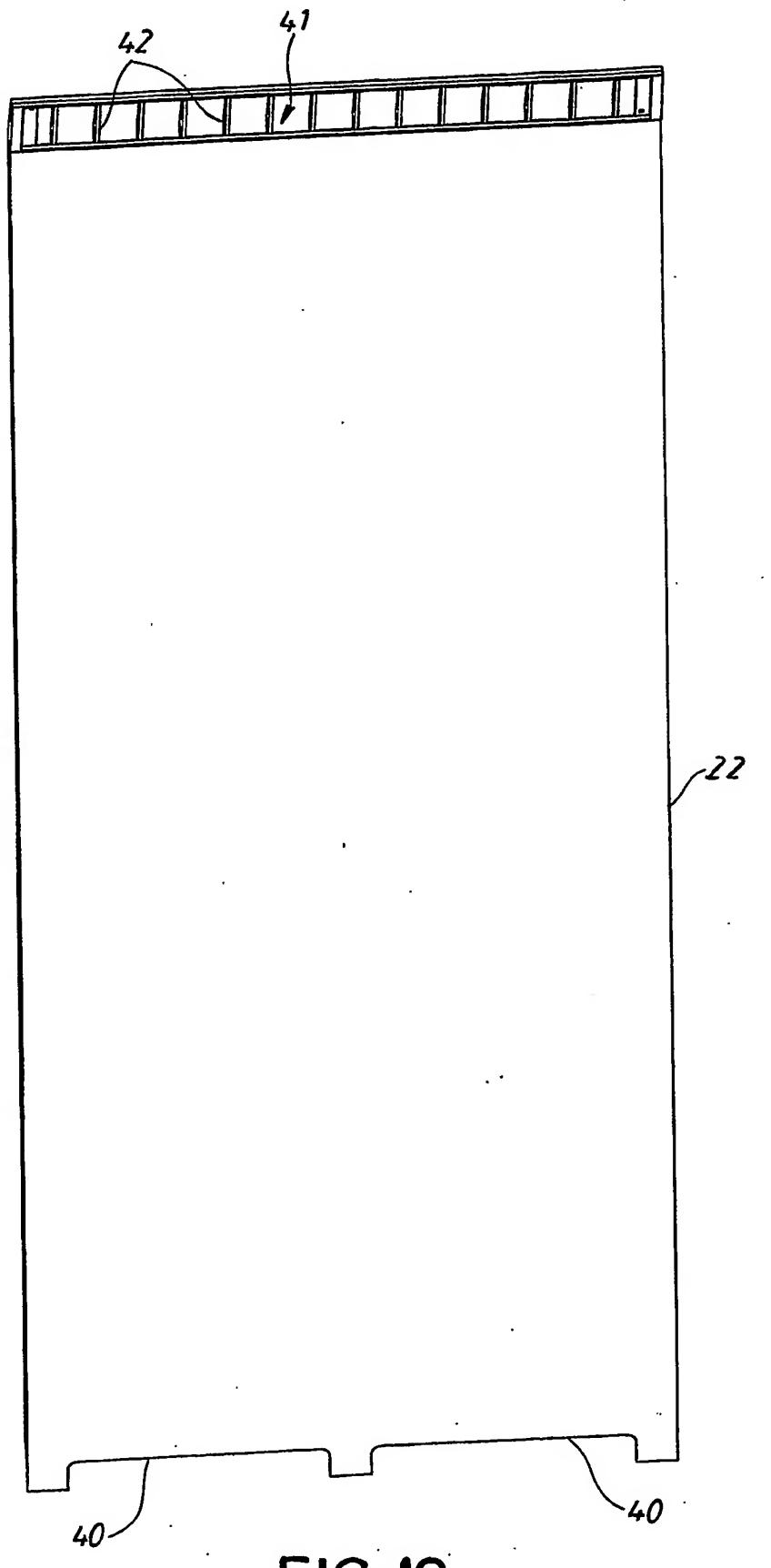
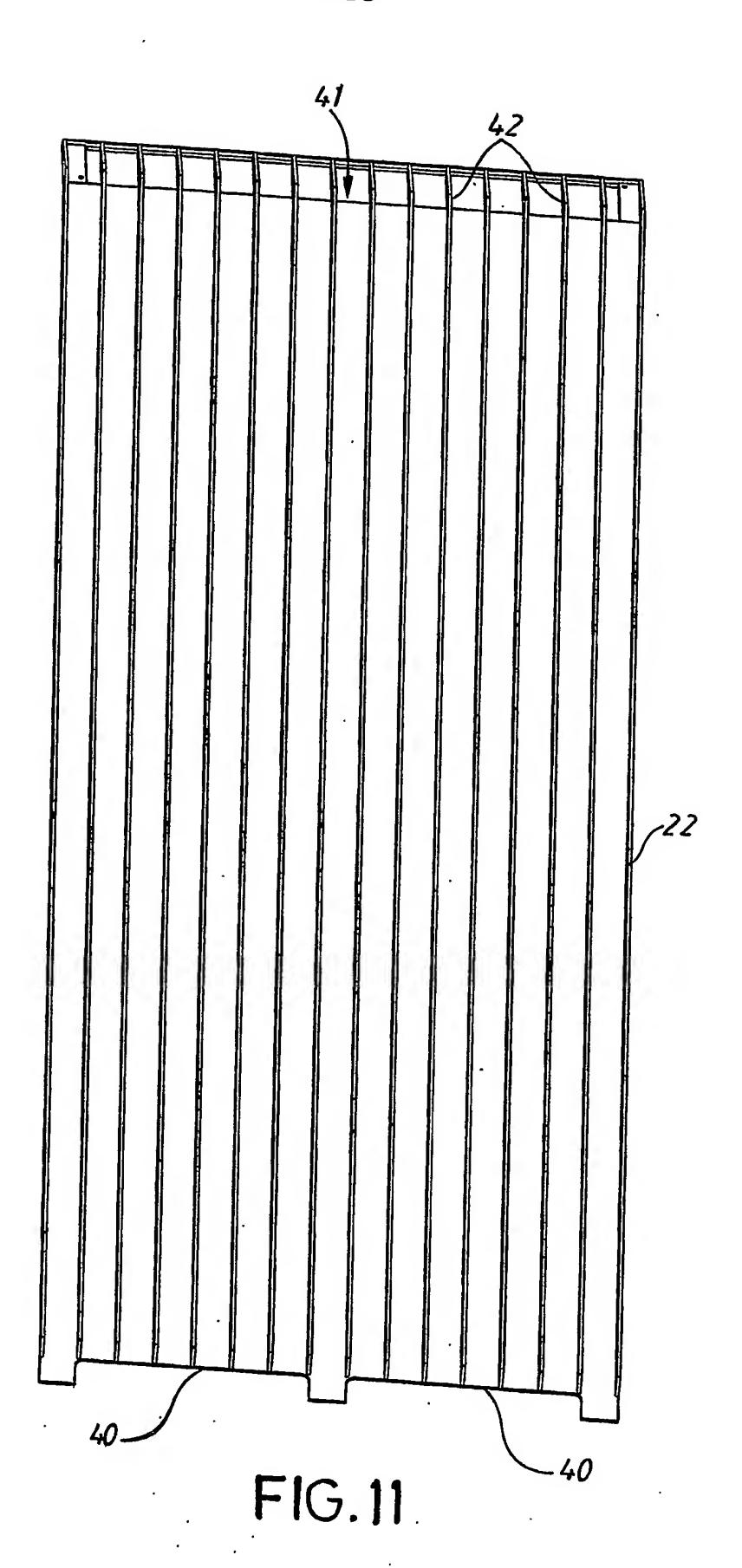
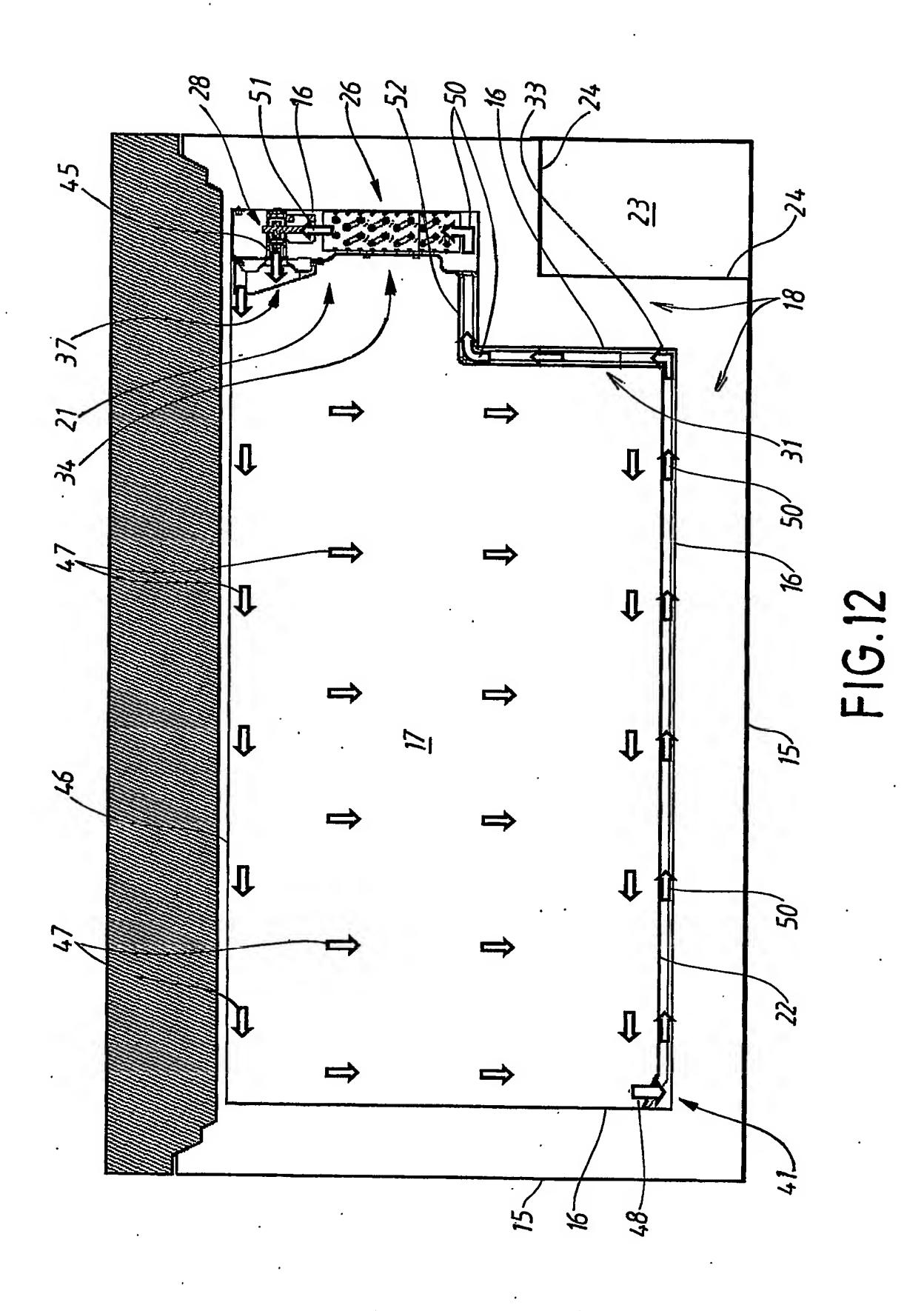


FIG. 10





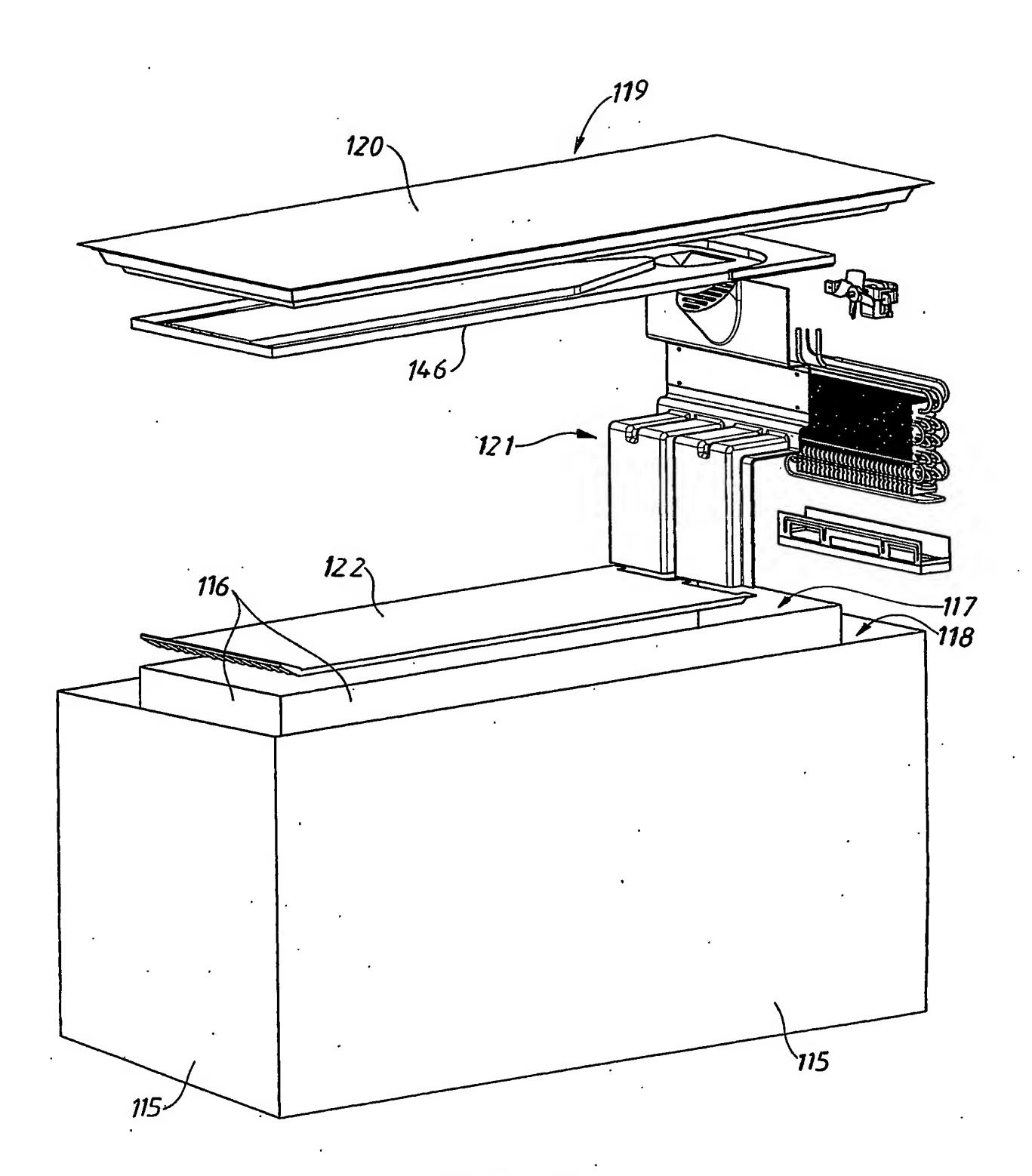


FIG. 13

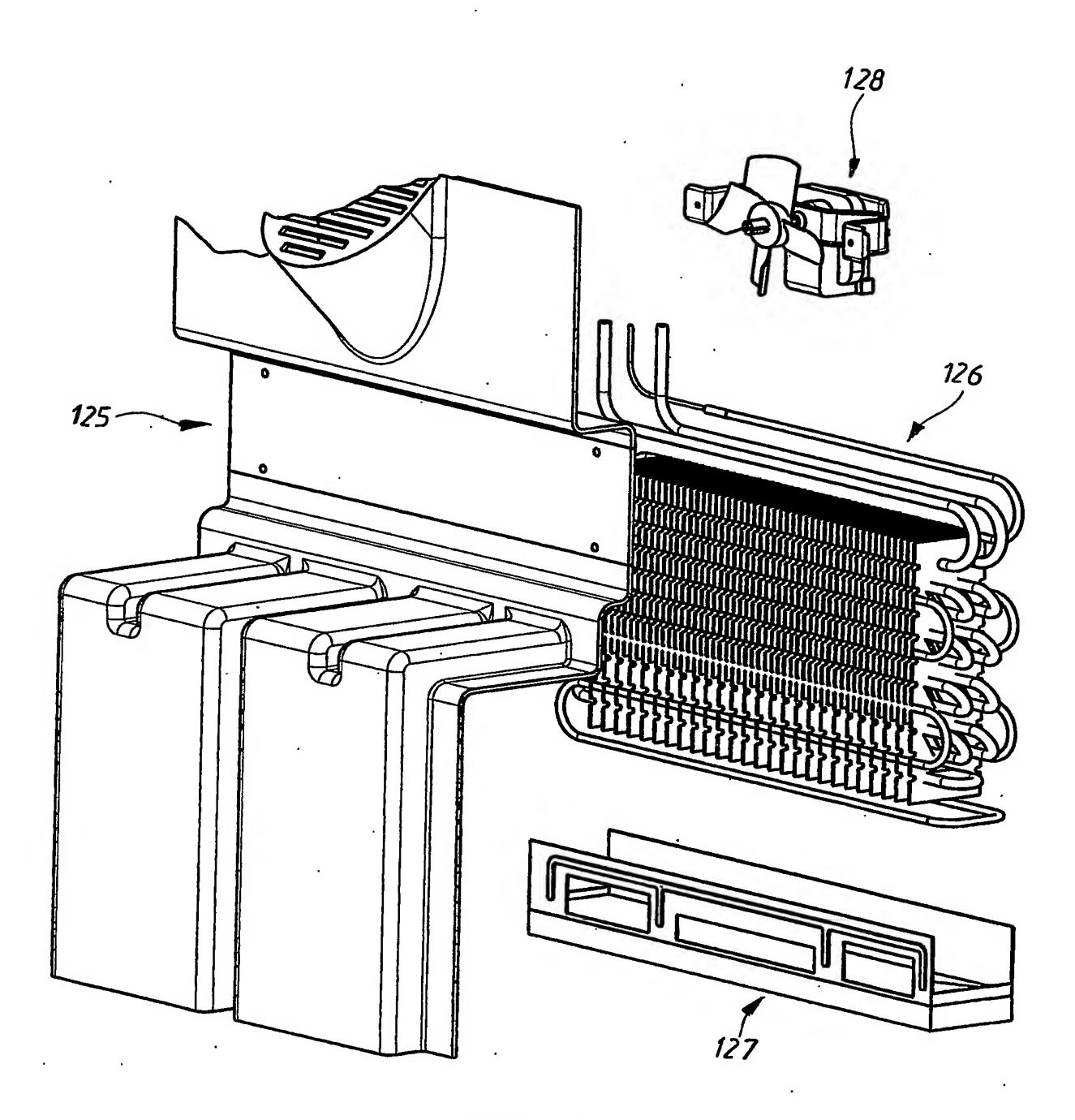
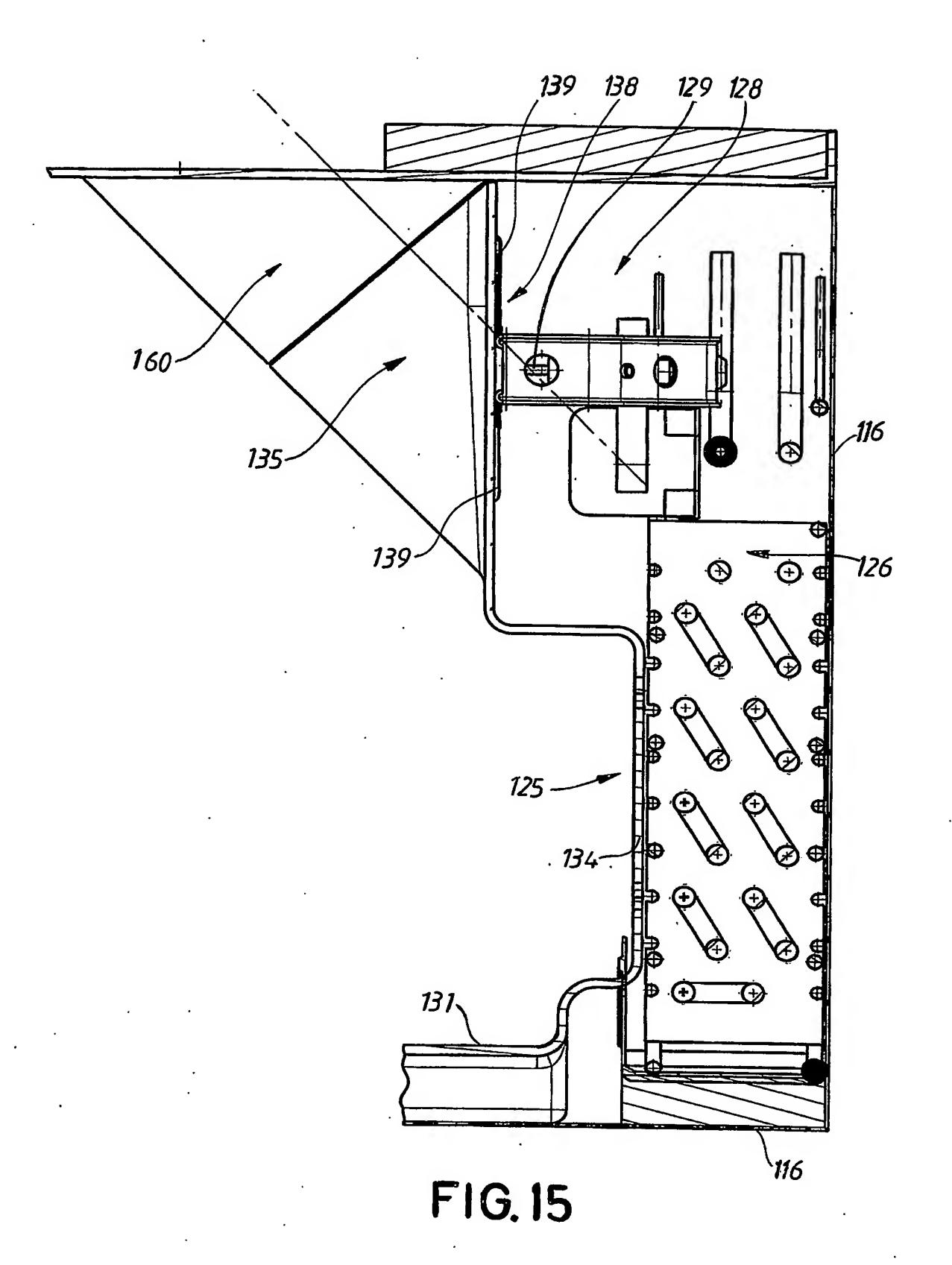
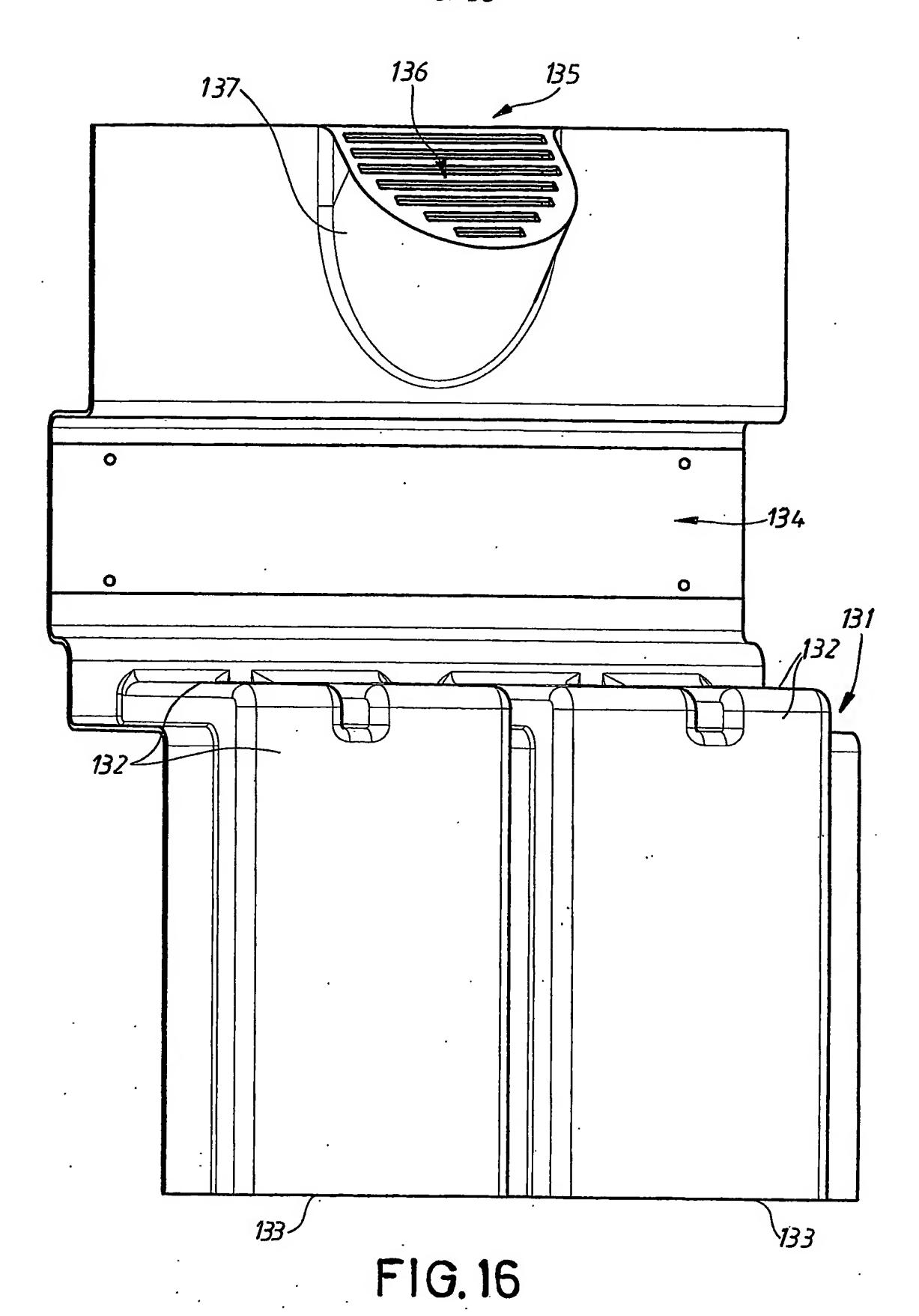


FIG. 14





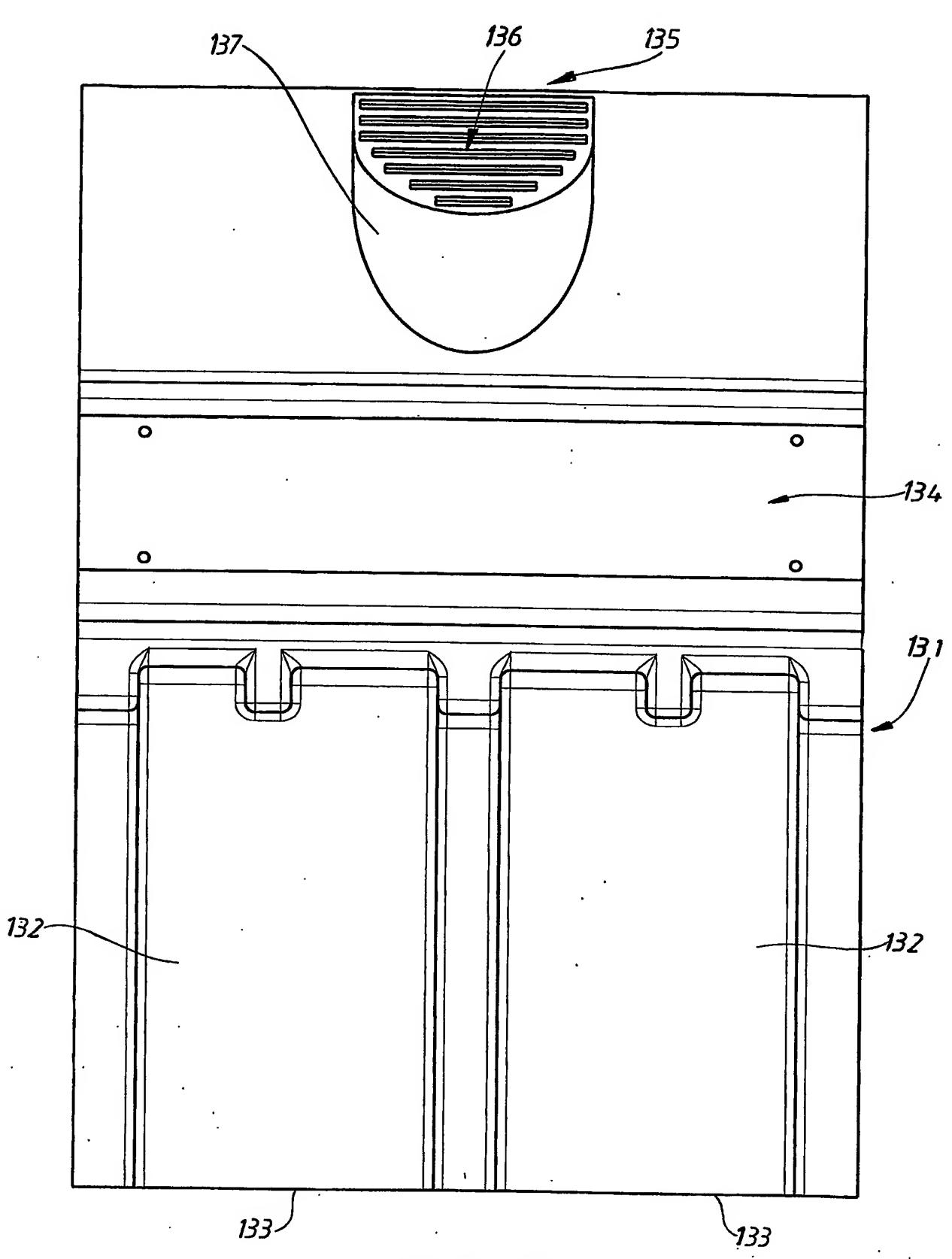


FIG. 17

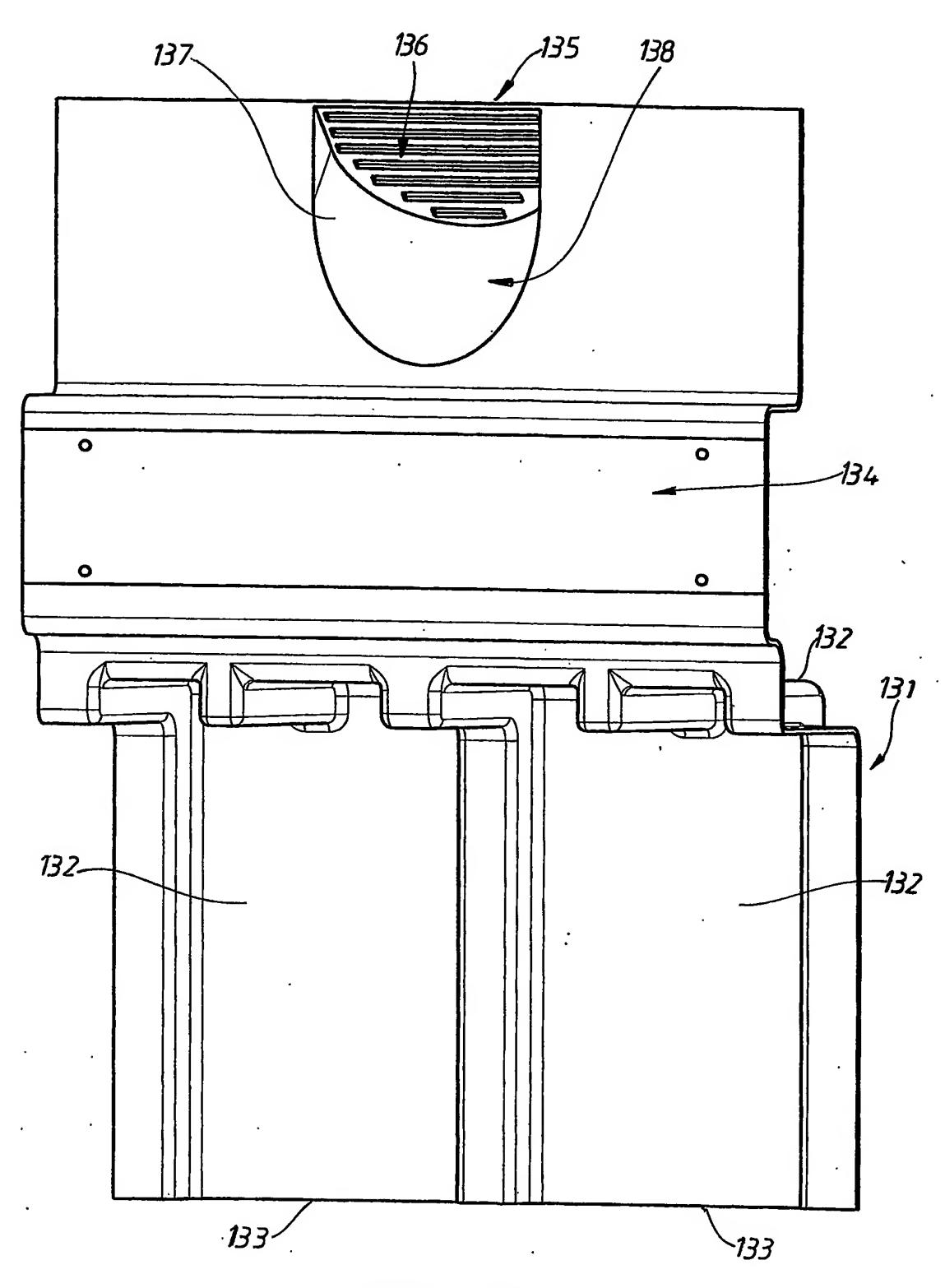
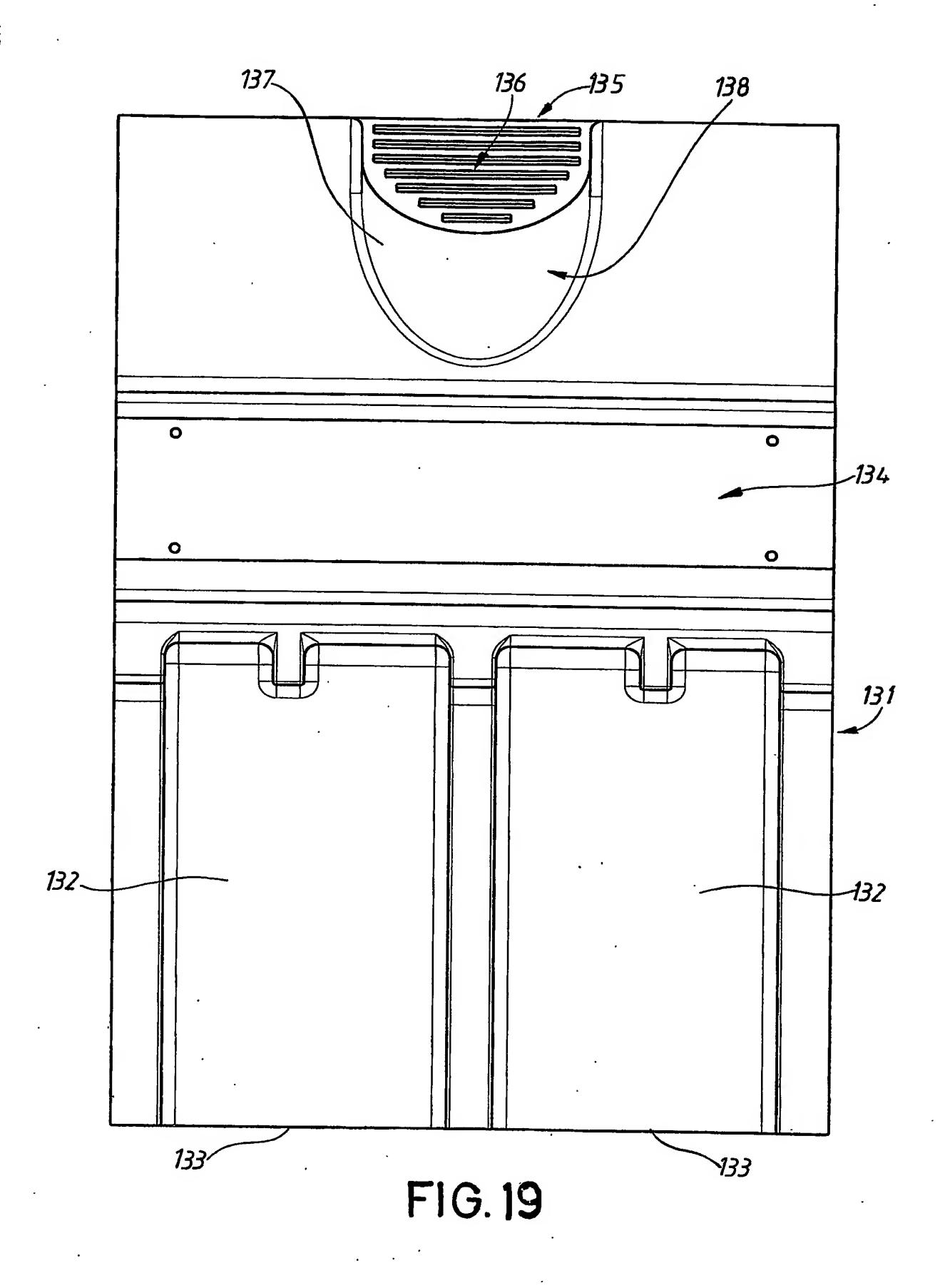


FIG. 18



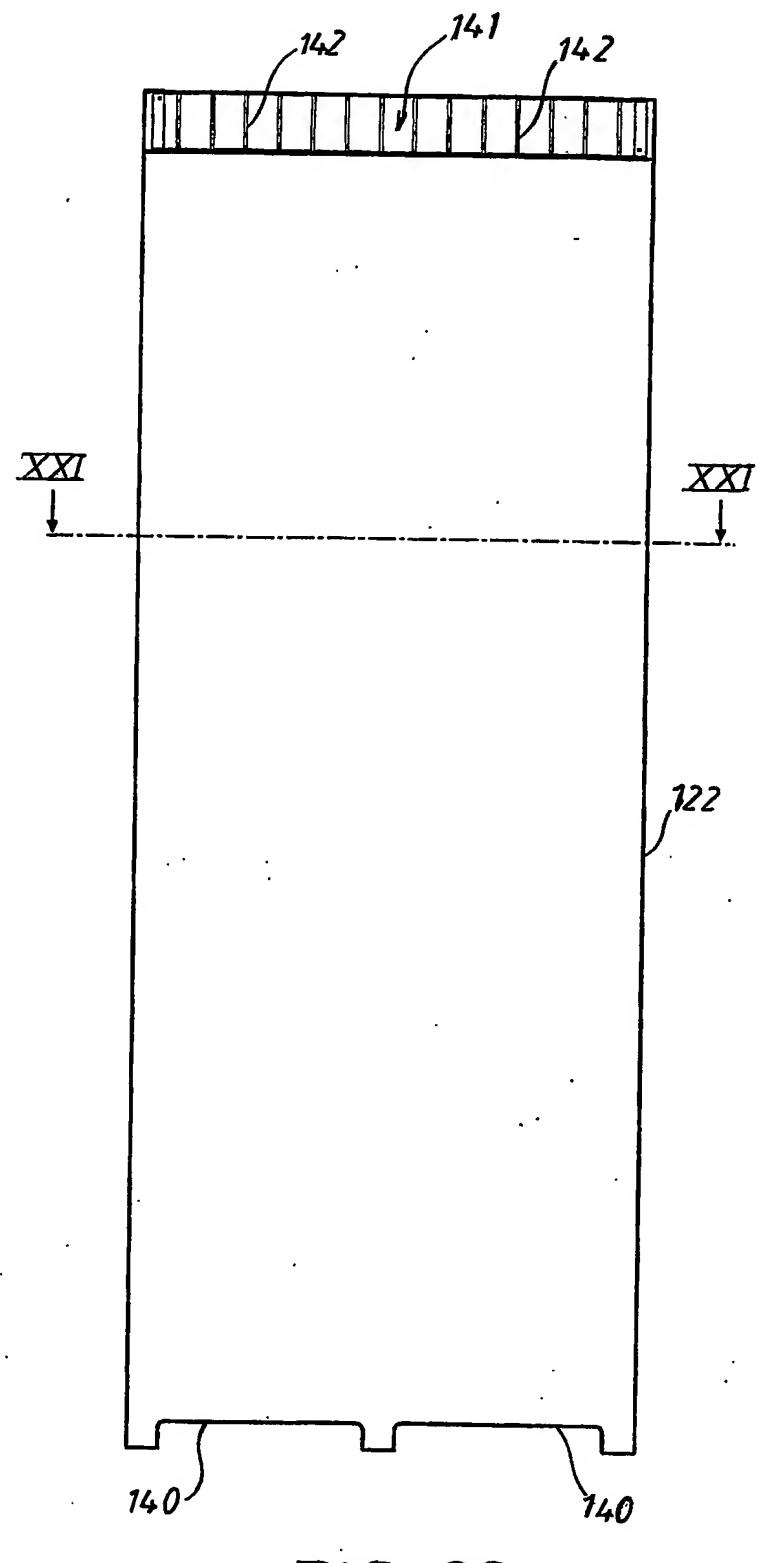


FIG. 20

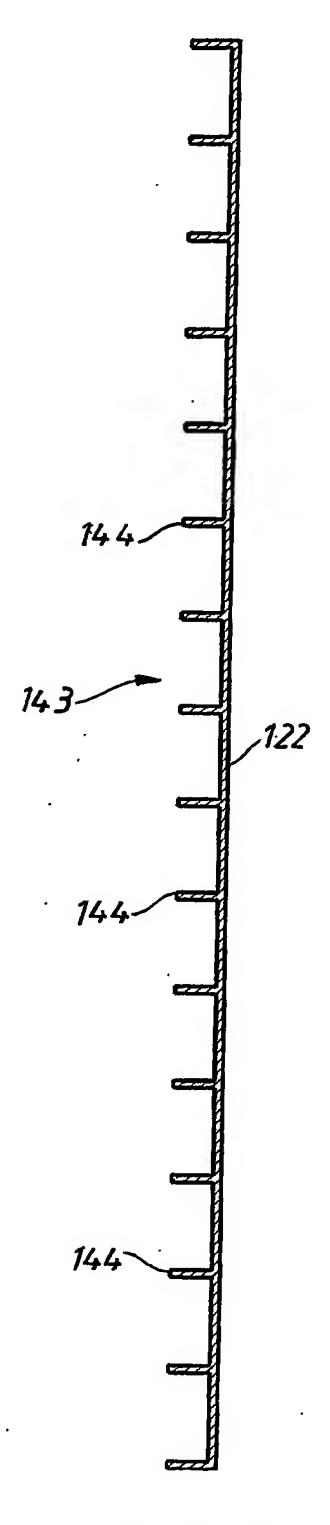


FIG. 21

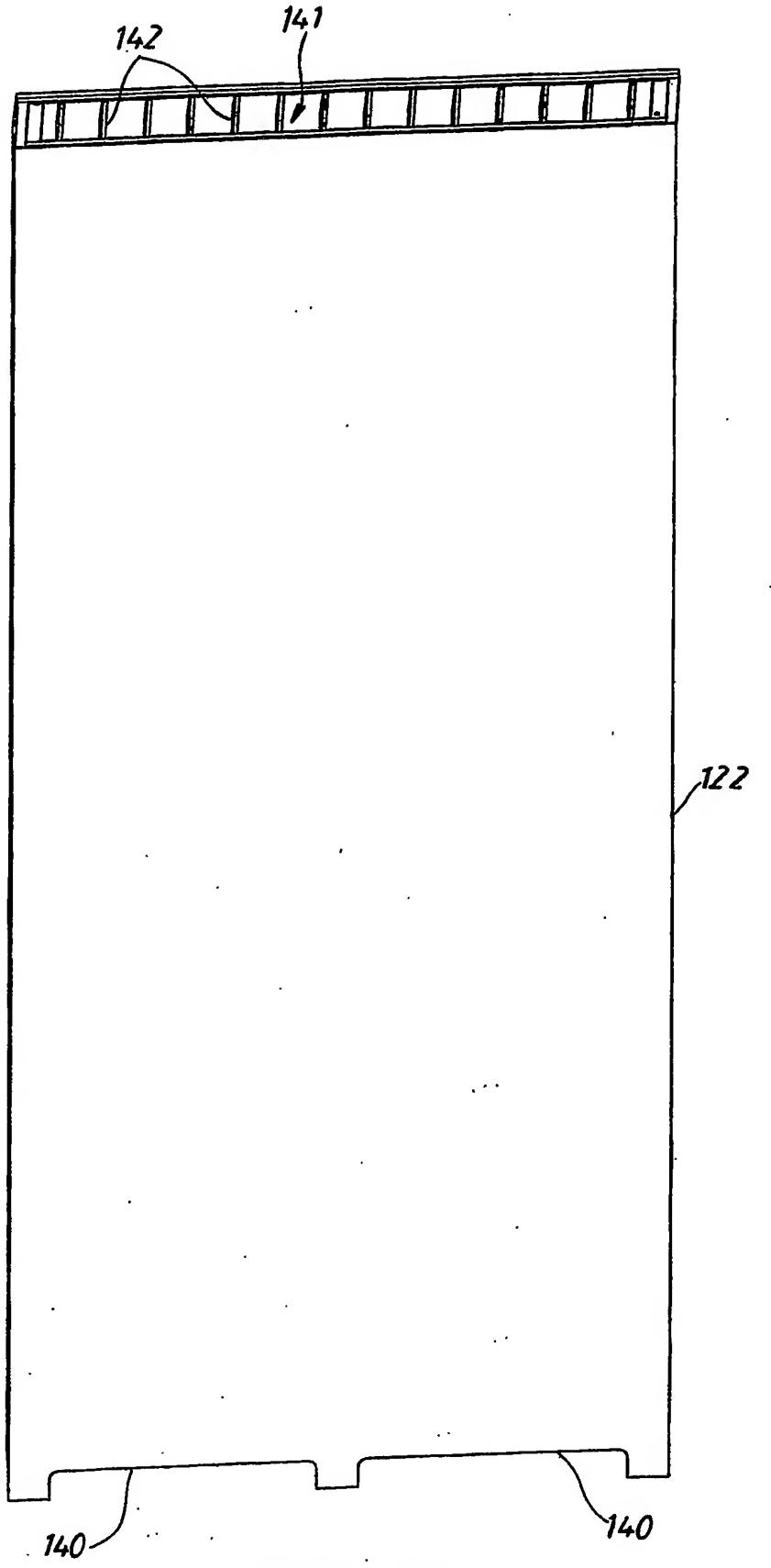
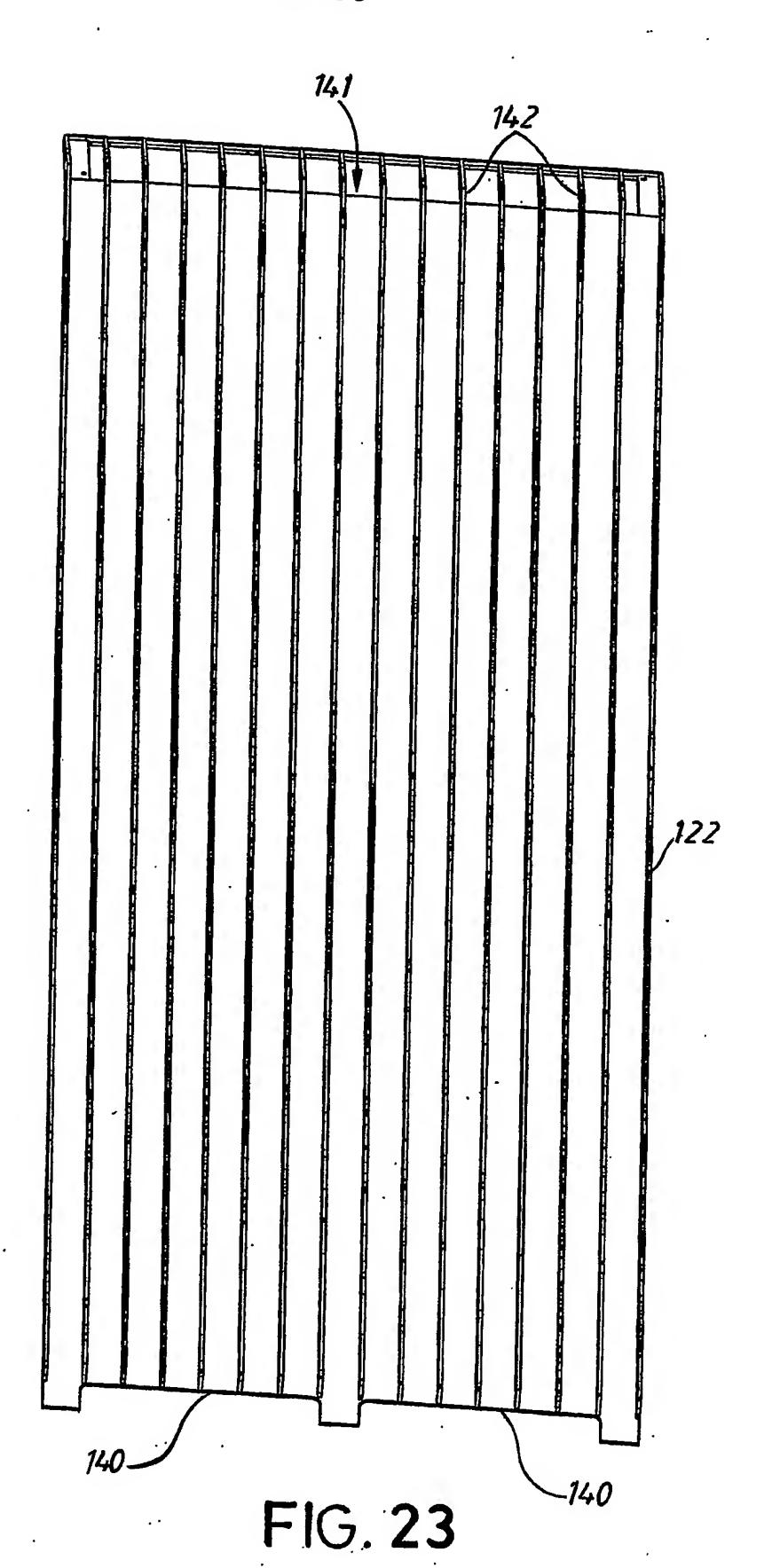


FIG. 22



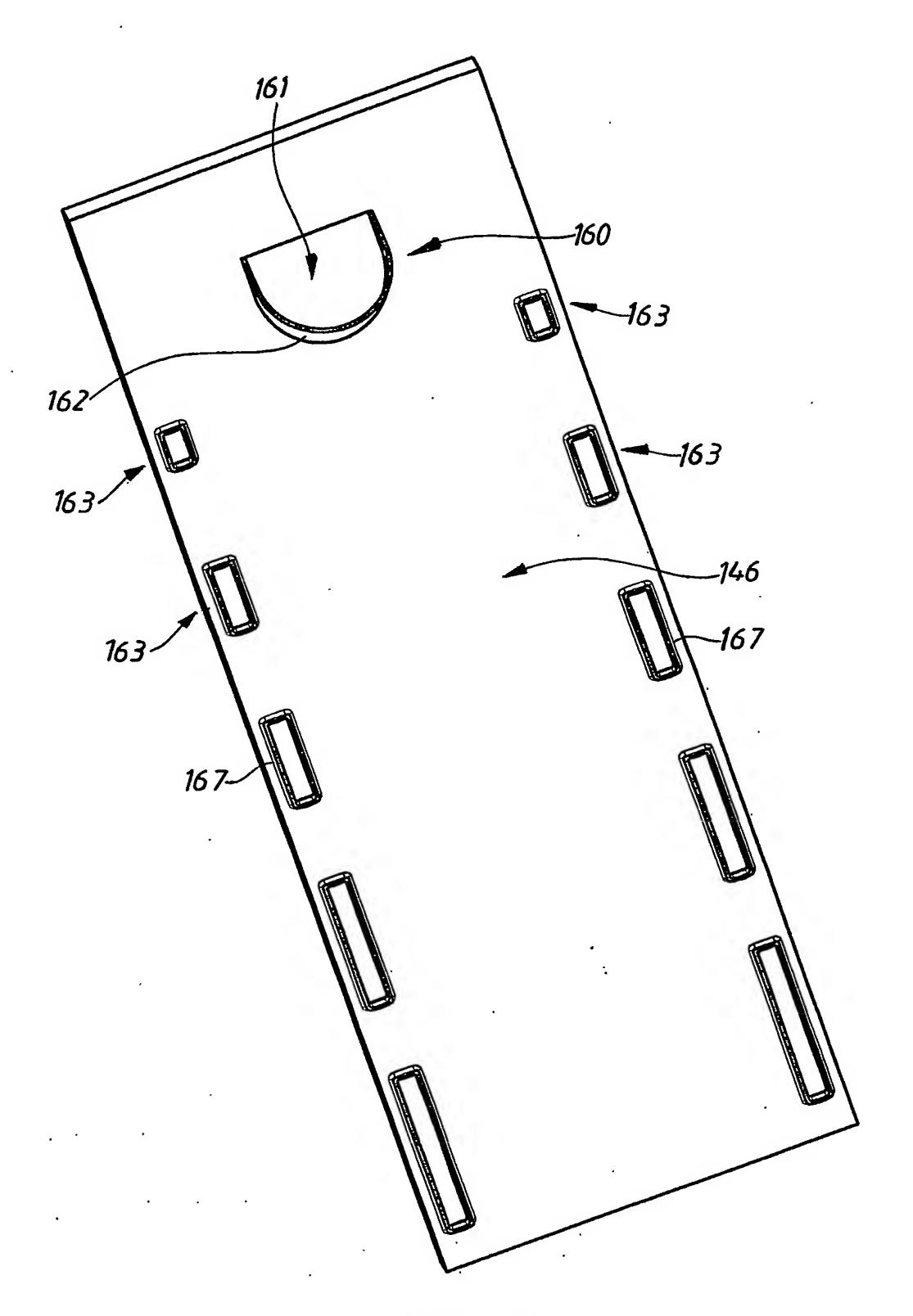


FIG. 24

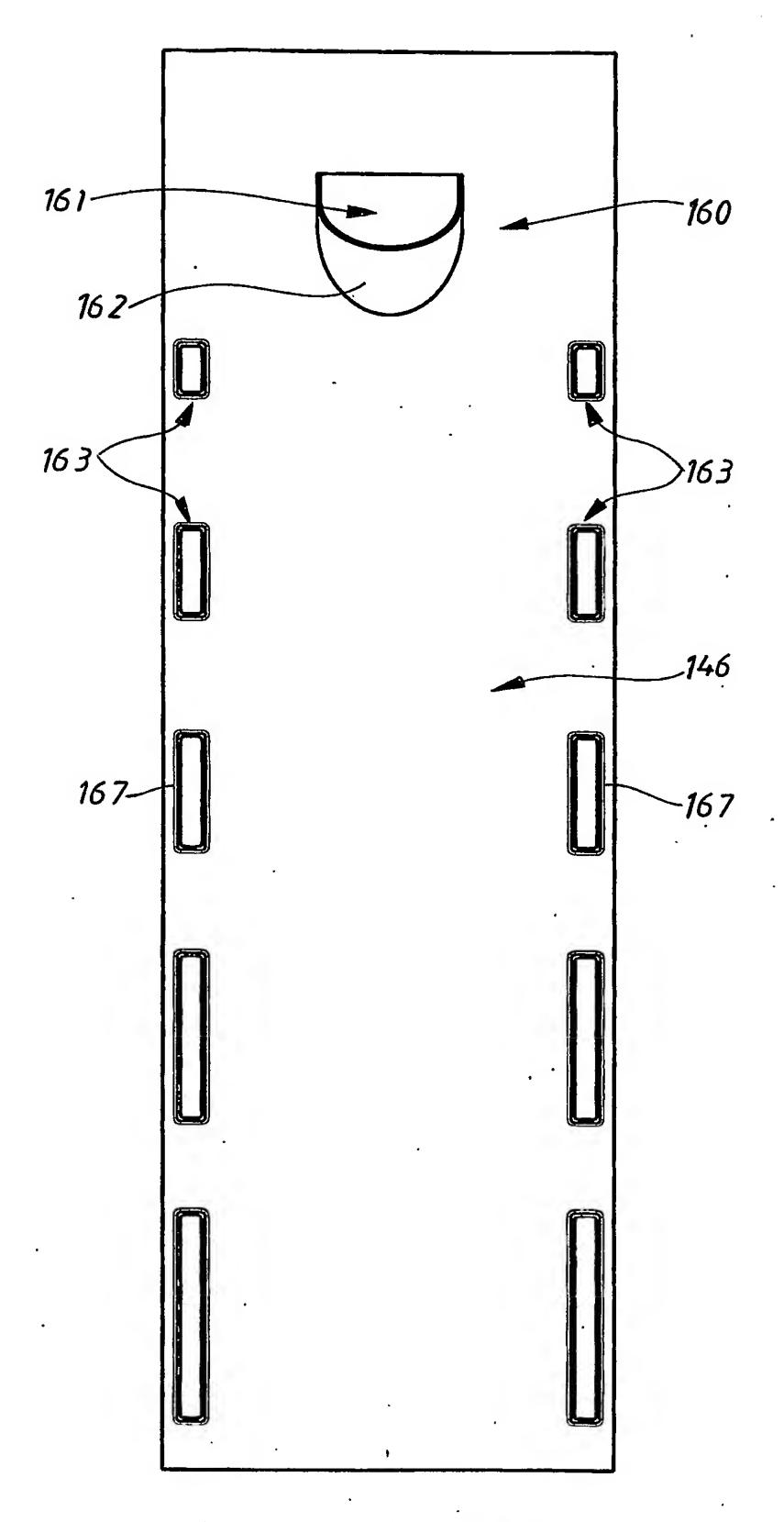


FIG. 25

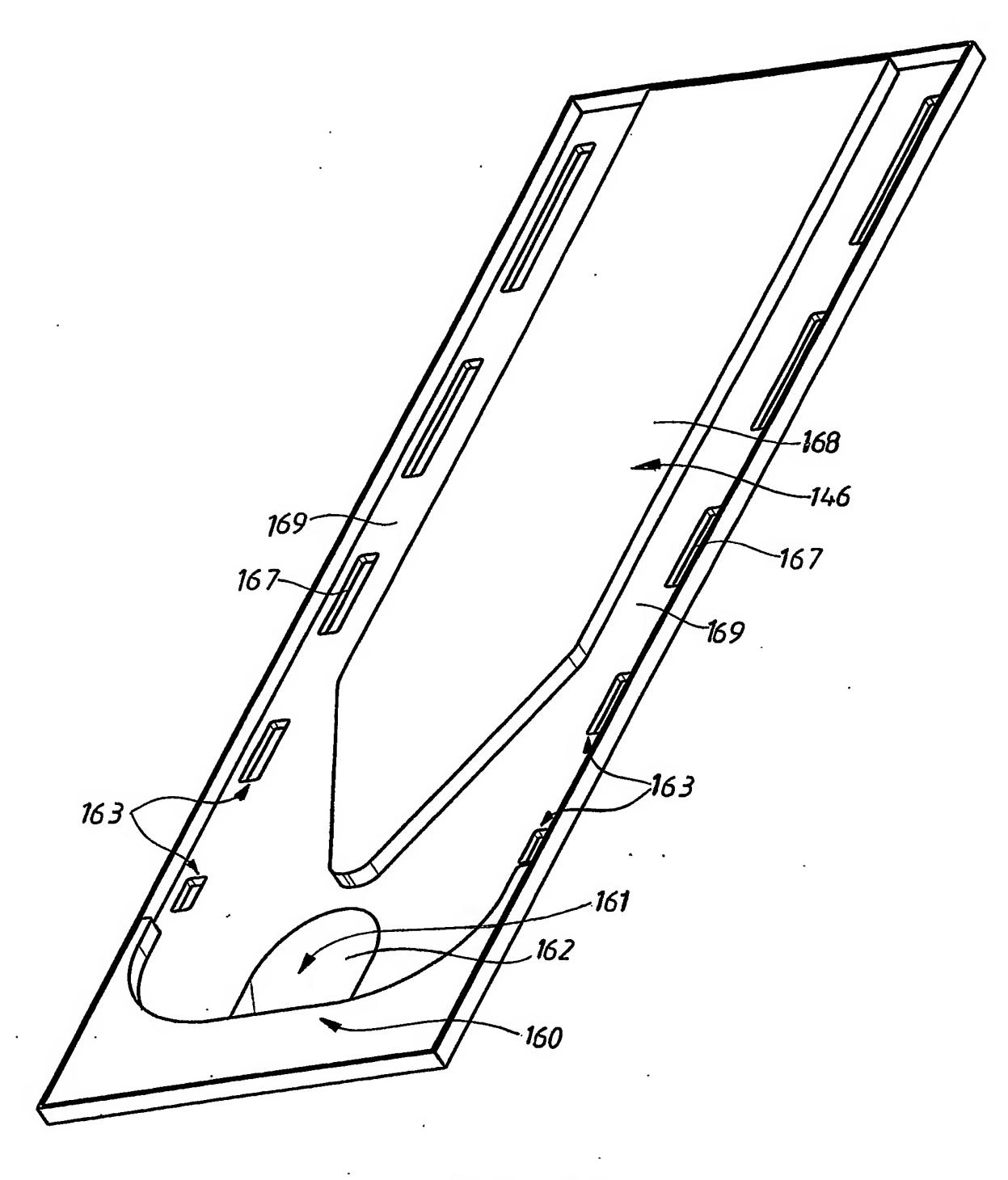


FIG. 26

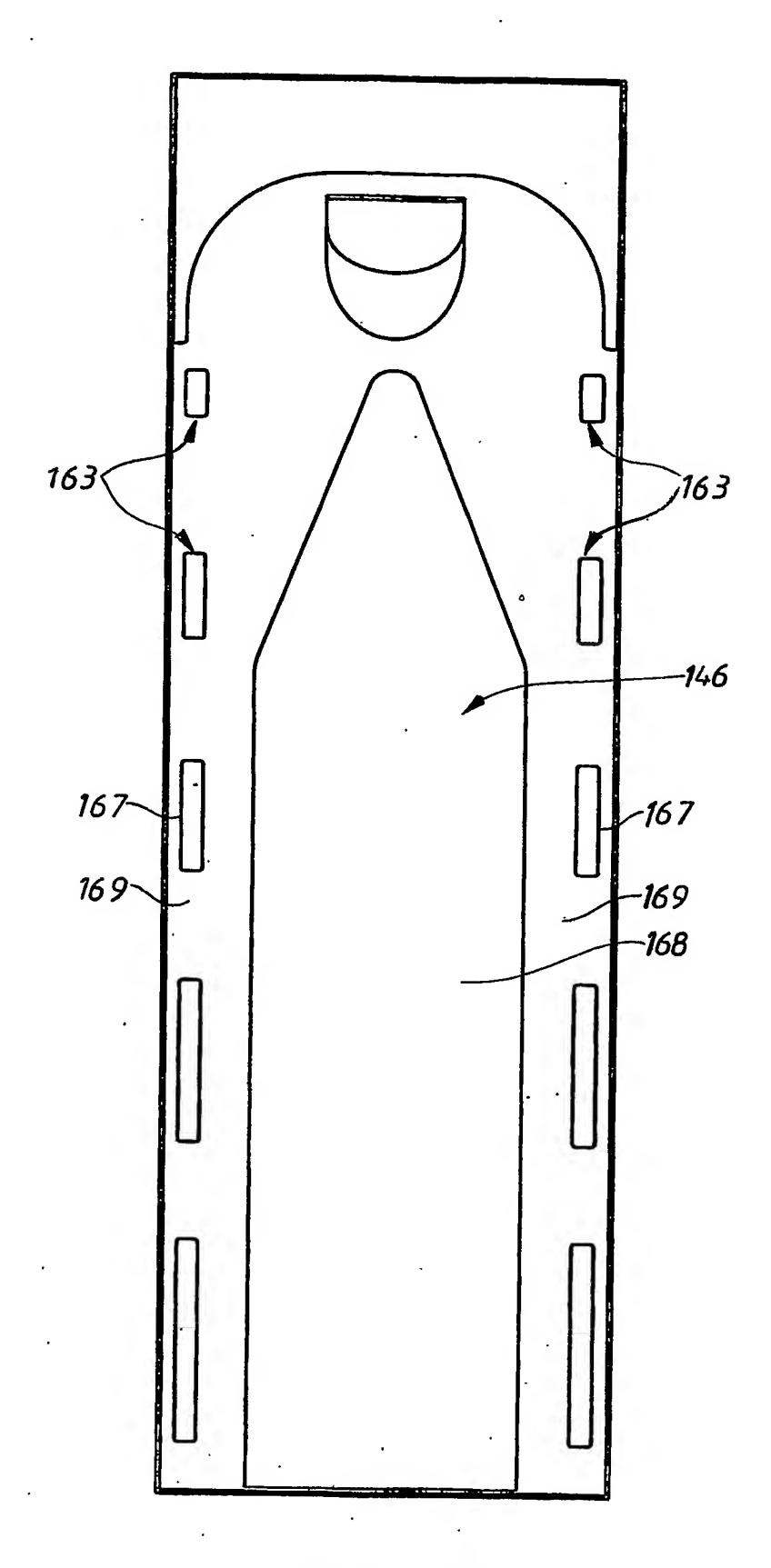


FIG. 27

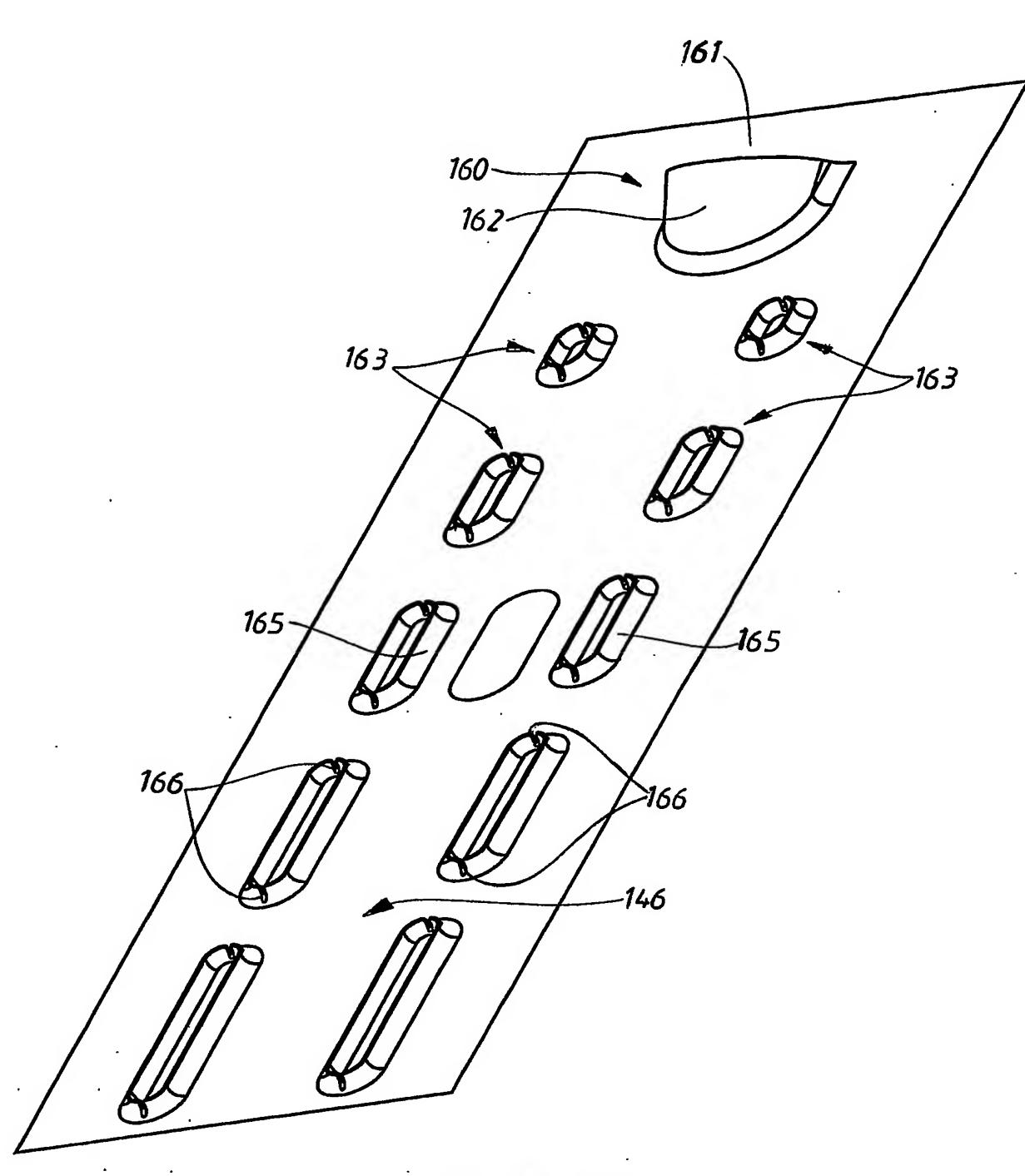


FIG. 28

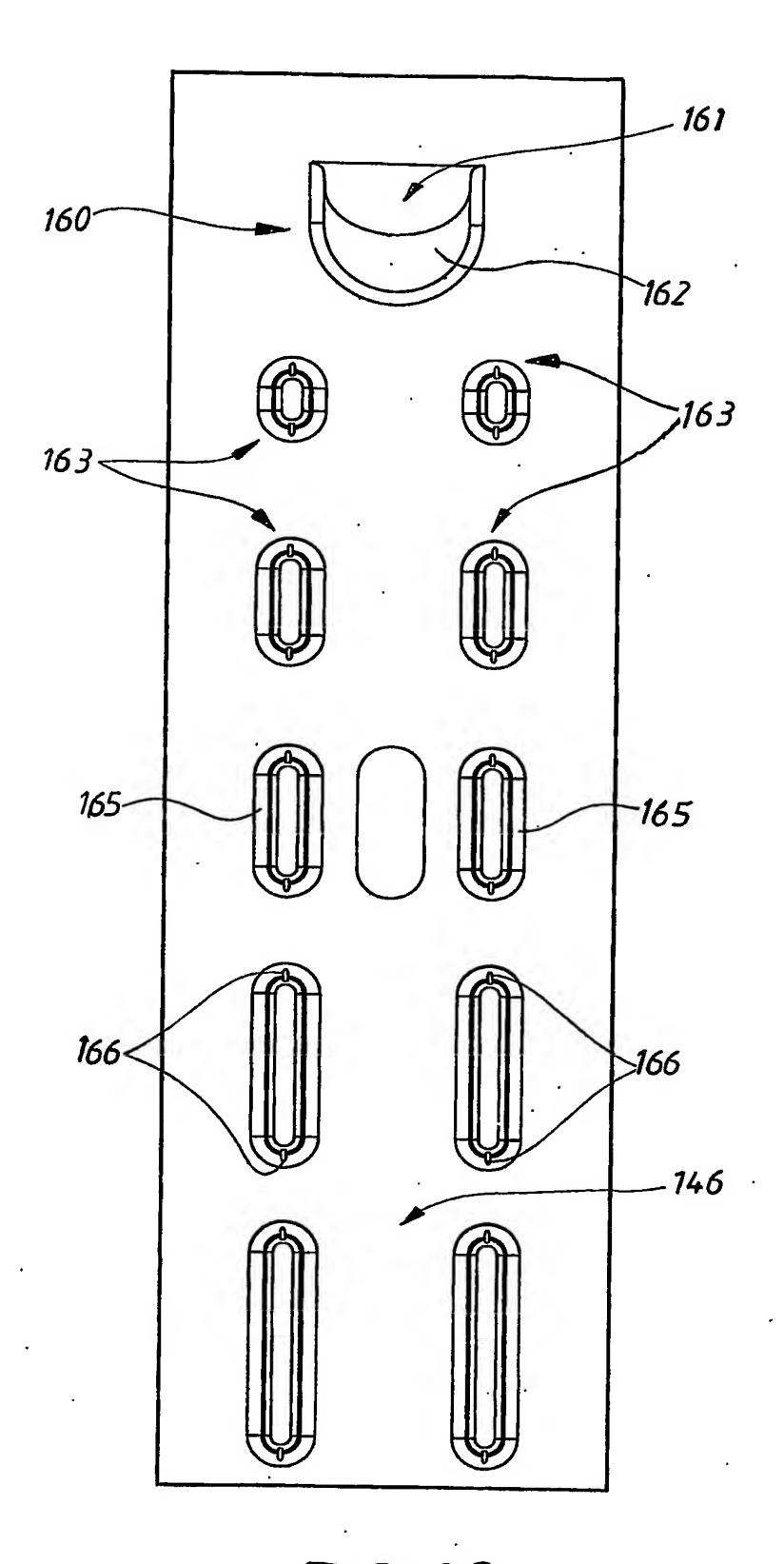


FIG. 29

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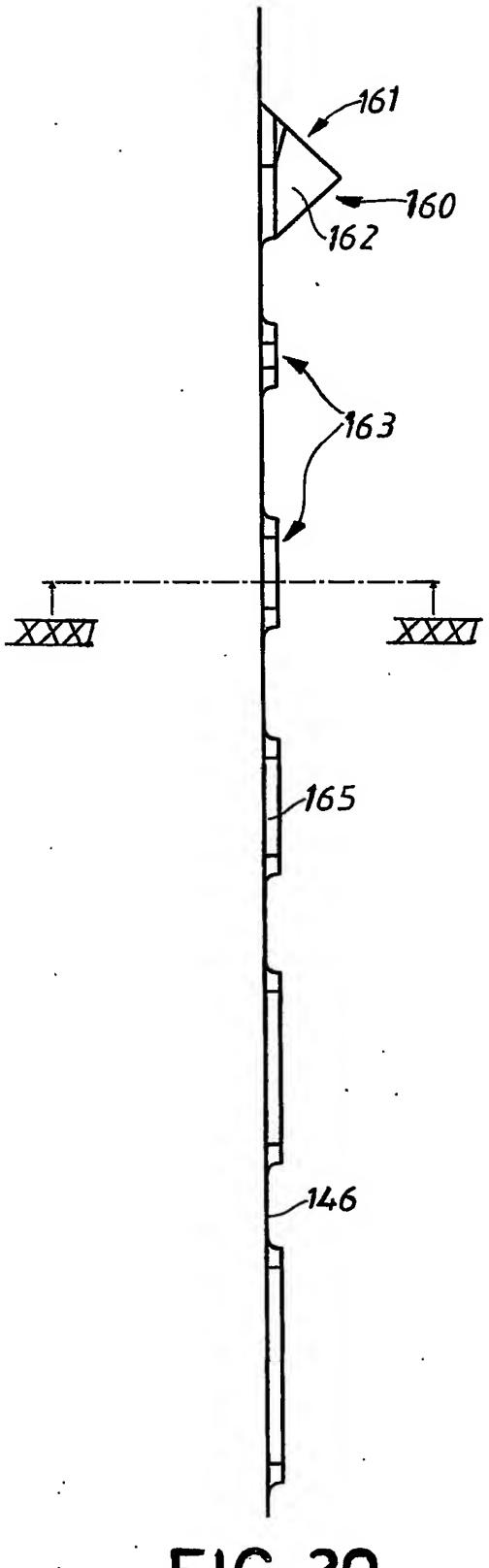


FIG. 30

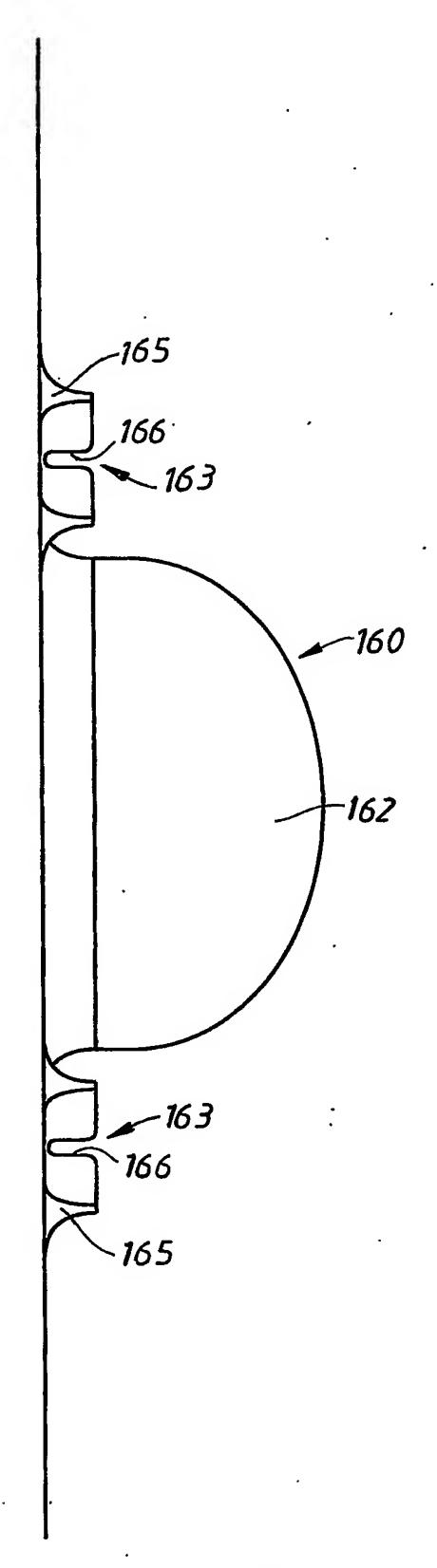
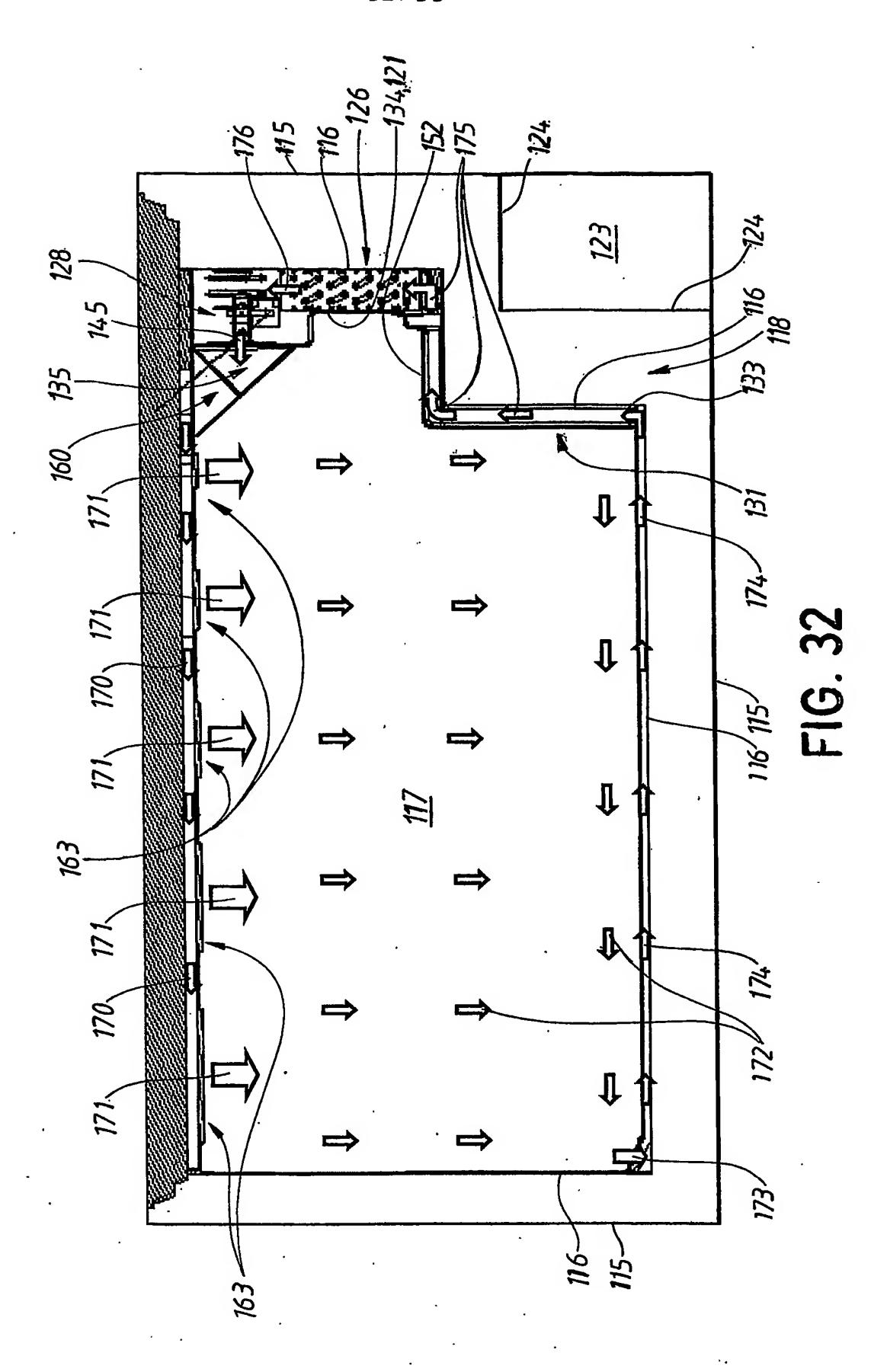
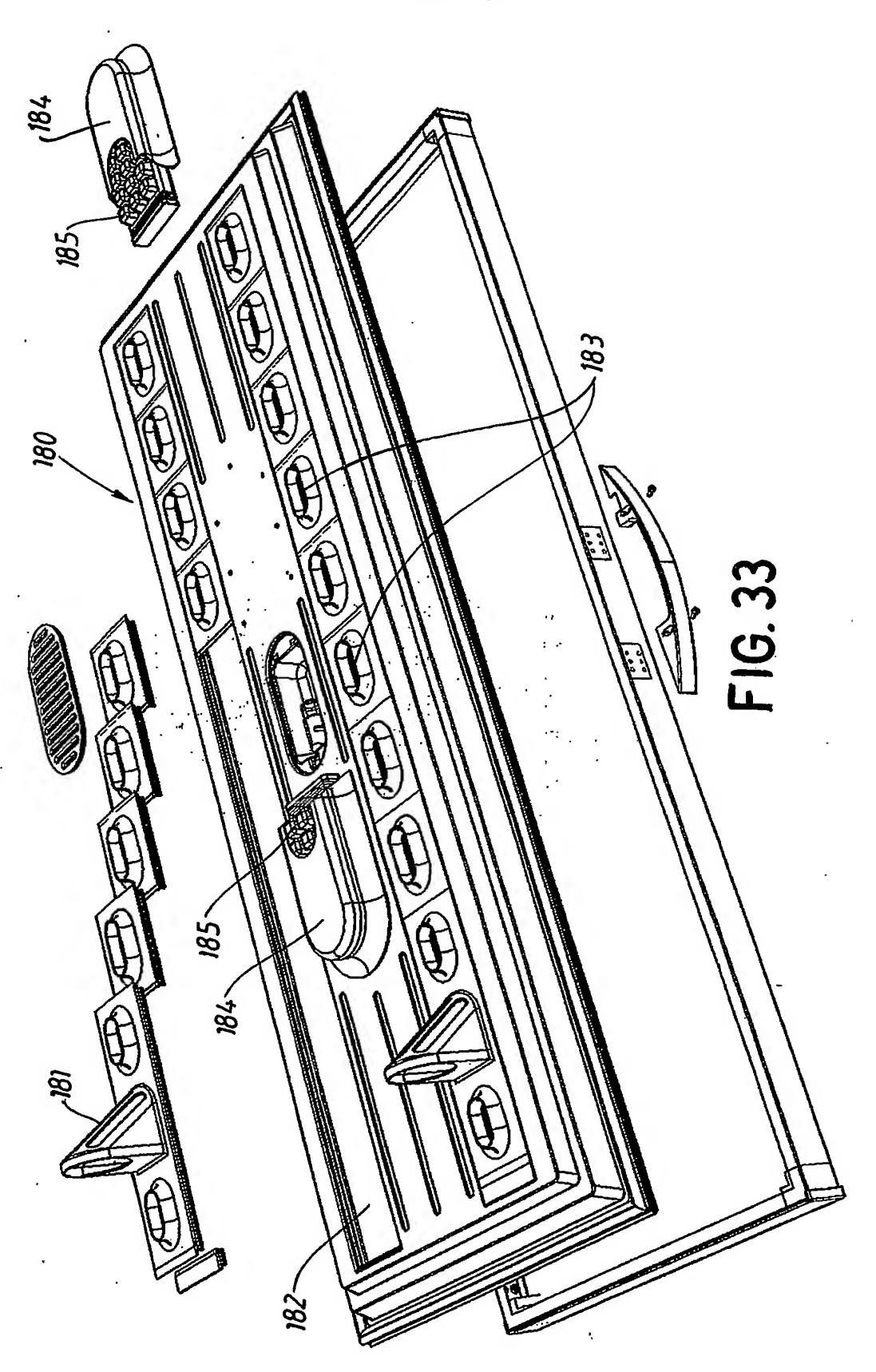


FIG. 31

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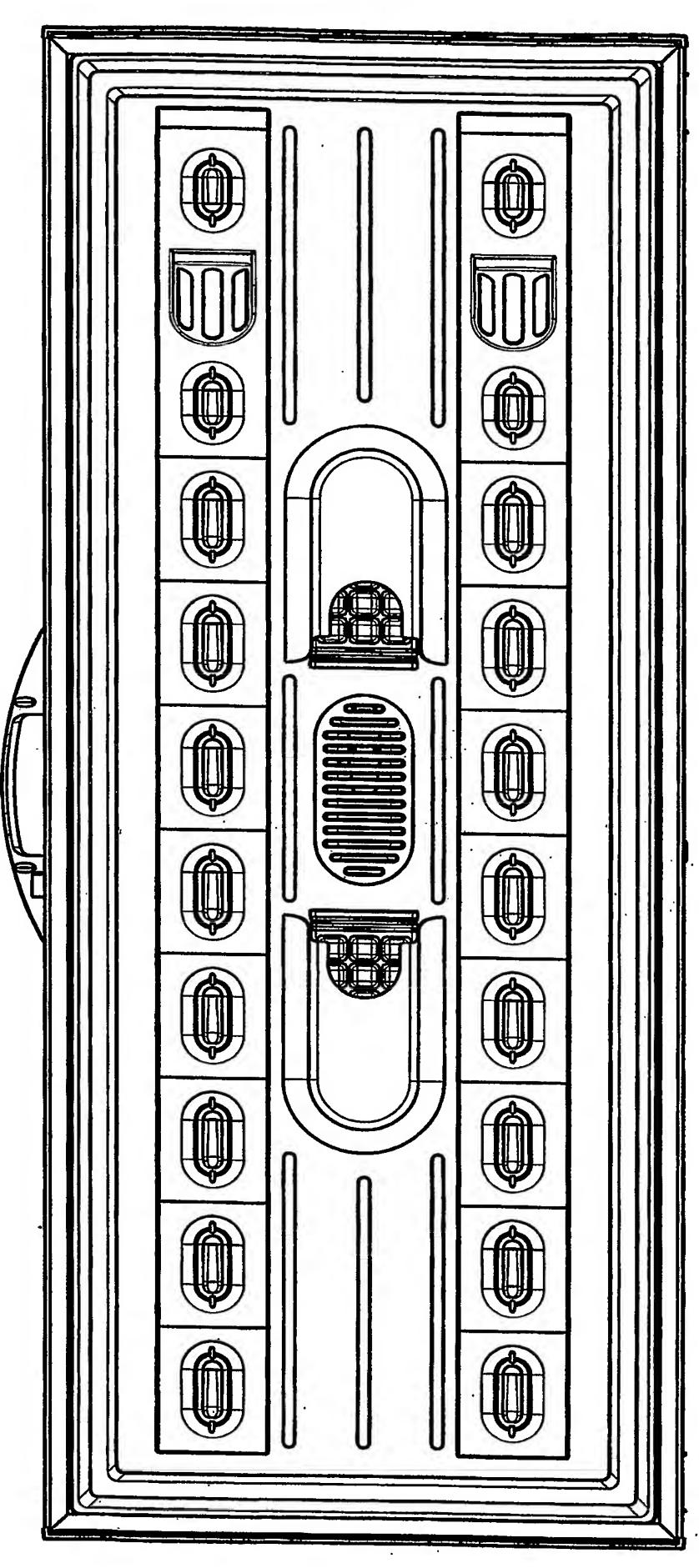
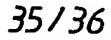
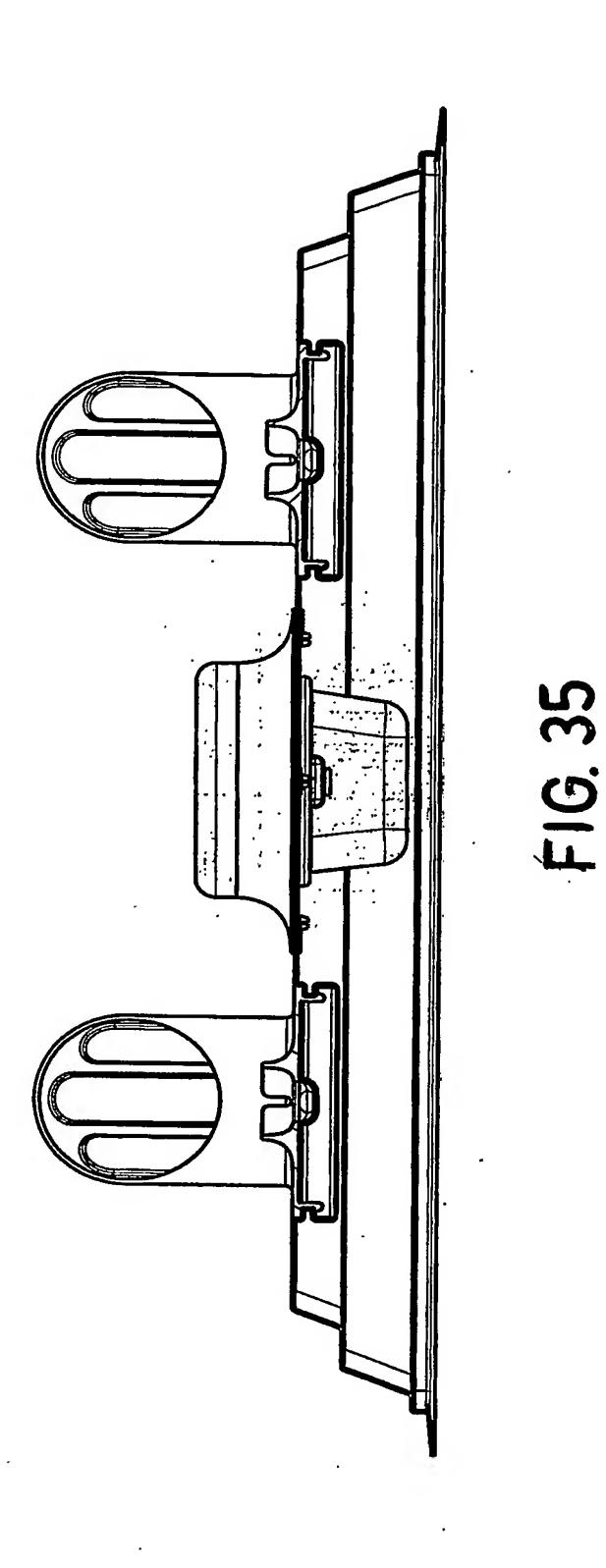


FIG. 34

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